128Mb B-die Page NOR Specification Dual Die Package (56TSOP) (64Mb x 2)

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Document Title

128M Bit (8M x16) Page Mode / Multi-Bank NOR Flash Memory / 56TSOP - Two 64M Bit NOR with 1 Chip Enable (A22 is virtual Chip Enable of 2nd Chip)

Revision History

Revision No.	<u>History</u>	<u>Draft Date</u>	<u>Remark</u>
0.0	Initial draft	November 14, 2006	Target Information
0.1	Part ID is changed from K8P2715UQB to K8Q2815UQB.	January 19, 2007	Target Information
0.2	- Group block protect time: 100us> 120us - Group block unprotect time: 1.2ms> 3ms In Figure 8. Block Group Protection & Unprotection Algorithms & Block Group Protect & Unprotect Operations timing	February 08, 2007	Target Information
0.5	 Page Read Current (Icc6) max. value is changed 15mA to 22mA Package dimension is added. 	March 21, 2007	Preliminary
0.6	- "#OE or #CE should be toggled in each toggle bit status read." is added in DQ2 & DQ6 toggle bit.	April 23, 2007	Preliminary
1.0	- Specification is finalized.	June 08, 2007	
1.1	 - Fast access time 55ns is deleted. - Absolute maximum ratings All other pins value is changed -0.5 to 2.5 to -0.5 to Vcc + 0.5. 	June 28, 2007	



128M Bit (8M x16) Page Mode / Multi-Bank NOR Flash Memory / 56TSOP - Two 64M Bit NOR with 1 Chip Enable (A22 is virtual Chip Enable of 2nd Chip)

FEATURES

- Single Voltage, 2.7V to 3.6V for Read and Write operations
- Organization
- 8M x16 bit (Word mode Only)
- Fast Read Access Time: 60ns
- Page Mode Operation
 - 8 Words Page access allows fast asychronous read Page Read Access Time: 20ns
- Read While Program/Erase Operation
- Multiple Bank architectures (8 banks)

Bank 0: 8Mbit (4Kw x 8 and 32Kw x 15)

Bank 1 :24Mbit (32Kw x 48)

Bank 2 : 24Mbit (32Kw x 48)

Bank 3: 8Mbit (4Kw x 8 and 32Kw x 15)

Bank 4: 8Mbit (4Kw x 8 and 32Kw x 15)

Bank 5:24Mbit (32Kw x 48)

Bank 6: 24Mbit (32Kw x 48)

Bank 7: 8Mbit (4Kw x 8 and 32Kw x 15)

- OTP Block : Extra 256 word
 - 128word for factory and 128word for customer OTP
- Power Consumption (typical value)
- Active Read Current: 45mA (@10MHz)
- Program/Erase Current: 17mA
- Read While Program or Read While Erase Current : 35mA
- Standby Mode/Auto Sleep Mode : 30uA (15uA for each chip)
- Support Single & Quad word accelerate program
- WP/ACC input pin
 - Allows special protection of two outermost boot blocks at VIL, regardless of block protect status (for each chip)
 - Removes special protection of two outermost boot block at ViH, the two blocks return to normal block protect status (for each chip)
 - Accelerated Quadword Program time: 1.5us
- Erase Suspend/Resume
- Program Suspend/Resume
- Unlock Bypass Program
- Hardware RESET Pin
- · Command Register Operation
- Block Protection / Unprotection
- Supports Common Flash Memory Interface
- Industrial Temperature : -40°C to 85°C

- Endurance: 100,000 Program/Erase Cycles Minimum
- Data Retention : 10 years
- Vccq options at 1.8V and 3V I/O
- Package options
- 56 Pin TSOP (20x14mm) only

GENERAL DESCRIPTION

The K8Q2815UQB featuring single 3.0V power supply, is an 128Mbit NOR-type Flash Memory organized as 8M x16. The memory architecture of the device is designed to divide its memory arrays into 284 blocks with independent hardware protection. This block architecture provides highly flexible erase and program capability. The K8Q2815UQB NOR Flash consists of eight banks. This device is capable of reading data from one bank while programming or erasing in the other banks.

The K8Q2815UQB offers fast page access time of 20~30ns with random access time of 60~70ns. The device's fast access times allow high speed microprocessors to operate without wait states. The device performs a program operation in unit of 16 bits (Word) and erases in units of a block. Single or multiple blocks can be erased. The block erase operation is completed within typically 0.7 sec. The device requires 15mA as program/ erase current in the industrial temperature ranges.

The K8Q2815UQB NOR Flash Memory is created by using Samsung's advanced CMOS process technology. This device is available in 56 Pin TSOP package. The device is compatible with EPROM applications to require high-density and cost-effective non-volatile read/write storage solutions.

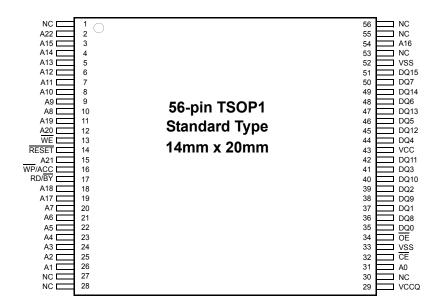
PIN DESCRIPTION

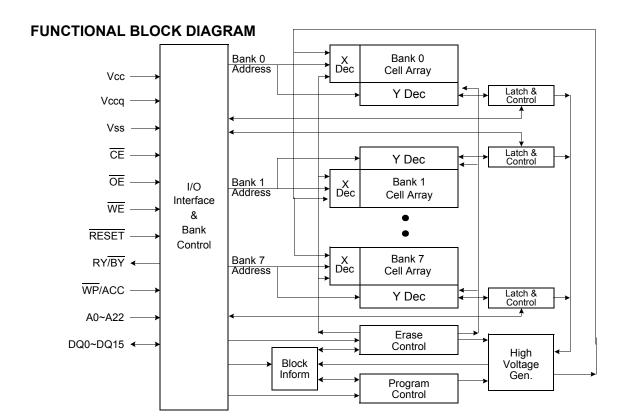
Pin Name	Pin Function
A0 - A22	Address Inputs (A22 : Virtual Chip Enable of 2nd Chip)
DQ0 - DQ15	Data Inputs / Outputs
CE	Chip Enable
ŌĒ	Output Enable
RESET	Hardware Reset Pin
RY/BY	Ready/Busy Output
WE	Write Enable
WP/ACC	Hardware Write Protection/Program Acceleration
Vcc	Power Supply
Vss	Ground
N.C	No Connection

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56TSOP PIN CONFIGURATION





ORDERING INFORMATION

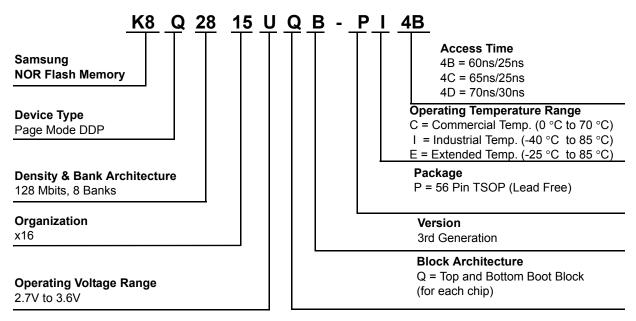


Table 1. PRODUCT LINE-UP

Speed Item	Speed Option							
ореец пені	4B	4C	4D					
Vcc		2.7V~3.6V						
Vccq (1)	1.65~1.95V , 2.7~3.6V							
Max. Address Access Time (ns)	60ns	65ns	70ns					
Max. CE Access Time (ns)	60ns	65ns	70ns					
Max. OE Access Time (ns)	25ns	25ns	30ns					
Max. Page Access Time (ns)	25ns	25ns	30ns					

Notes:

Table 2. K8Q2815UQB DEVICE BANK DIVISIONS

Bank 0, E	ank 3,Bank 4, Bank 7	Bank 1,	Bank 2, Bank 5, Bank 6
Mbit	Block Sizes	Mbit	Block Sizes
8 Mbit	4 Kw x 8 and 32 Kw x 15	24 Mbit	32 Kw x 48

Table 3. OTP BLOCK (Chip 1, A22='0')

	Block Address A21~A8	Area	Block Size	Address Range
OTP	0000h	Factory-Locked Area	128 words	000000h-00007Fh
	000011	Customer-Locked Area	128 words	000080h-0000FFh

After entering OTP block, any issued addresses should be in the range of OTP block address



^{1.} Only 4C or 4D speed options can be provided in case of using 1.65~1.95V Vccq.

Table 4. K8Q2815UQB DEVICE BANK DIVISIONS

Bank	Number of Blocks	Block Size
0	8	4 Kwords
U	15	32 Kwords
1	48	32 Kwords
2	48	32 Kwords
3	15	32 Kwords
3	8	4 Kwords
4	8	4 Kwords
4	15	32 Kwords
5	48	32 Kwords
6	48	32 Kwords
7	15	32 Kwords
1	8	4 Kwords

- 1. K8Q2815UQB is consist of two 64Mb. 2. Boot block is located in Bank 0, Bank 3, Bank 4, Bank 7

PRODUCT INTRODUCTION

The K8Q2815UQB is an 128Mbit NOR-type Flash memory. The device features single voltage power supply operating within the range of 2.7V to 3.6V. The device is programmed by using the Channel Hot Electron (CHE) injection mechanism which is used to program EPROMs. The device is erased electrically by using Fowler-Nordheim tunneling mechanism. To provide highly flexible erase and program capability, the device adapts a block memory architecture that divides its memory array into 284 blocks (4 Kw x 32 , 32 Kw x 252). Programming is done in units of 16 bits (Word). All bits of data in one or multiple blocks can be erased simultaneously when the device executes the erase operation. To prevent the device from accidental erasing or over-writing the programmed data, 284 memory blocks can be hardware protected. The device offers fast page access time of $20\sim30$ ns with random access time of $60\sim70$ ns supporting high speed microprocessors to operate without any wait states.

The command set of K8Q2815UQB is fully compatible with standard Flash devices. The device is controlled by chip enable $(\overline{\text{CE}})$, output enable $(\overline{\text{OE}})$ and write enable $(\overline{\text{WE}})$. Device operations are executed by selective command codes. The command codes to be combined with addresses and data are sequentially written to the command registers using microprocessor write timing. The command codes serve as inputs to an internal state machine which controls the program/erase circuitry. Register contents also internally latch addresses and data necessary to execute the program and erase operations. The K8Q2815UQB is implemented with Internal Program/Erase Algorithms to execute the program/erase operations. The Internal Program/Erase Algorithms are invoked by program/erase command sequences. The Internal Program Algorithm automatically programs and verifies data at specified addresses. The Internal Erase Algorithm automatically pre-programs the memory cell which is not programmed and then executes the erase operation. The K8Q2815UQB has means to indicate the status of completion of program/erase operations. The status can be indicated via the RY/BY pin, $\overline{\text{Data}}$ polling of DQ7, or the Toggle bit (DQ6). Once the operations have been completed, the device automatically resets itself to the read mode.

Table 5. Operations Table

Operation	CE	ŌE	WE	WP/ ACC	A22	А9	A6	A1	A0	DQ8/ DQ15	DQ0/ DQ7	RES ET
Read	L	L	Н	L/H	L/H	A9	A6	A1	A0	Douт	Dout	Н
Stand-by	Vcc ± 0.2V	Х	Х	(2)	L/H	Х	Х	Х	Х	High-Z	High-Z	(2)
Output Disable	L	Н	Н	L/H	L/H	Х	Х	Х	Х	High-Z	High-Z	Н
Reset	Х	Х	Х	L/H	L/H	Х	Х	Х	Х	High-Z	High-Z	L
Write	L	Н	L	(4)	L/H	A9	A6	A1	A0	Din	Din	Н
Enable Block Protect (3)	L	Н	L	L/H	L/H	Х	L	Н	L	Х	Din	VID
Enable Block Unprotect (3)	L	Н	L	(4)	L/H	Х	Н	Н	L	Х	Din	VID
Temporary Block Unprotect	Х	Х	Х	(4)	L/H	Х	Х	Х	Х	Х	Х	VID
Auto Select Manufacturer ID (5)	L	L	Н	L/H	L	VID	L	L	L	х	Code(See Table 7)	Н
Auto Select Device Code (5)	L	L	Н	L/H	L	VID	L	L	Н	х	Code(See Table 7)	Н

Notes :

- 1. L = VIL (Low), H = VIH (High), VID = 8.5V to 9.5V, DIN = Data in, DOUT = Data out, X = Don't care.
- 2. WP/ACC and RESET pin are asserted at Vcc±0.2 V or Vss±0.2 V in the Stand-by mode.
- Addresses must be composed of the Block address (A12 A22).
 The Block Protect and Unprotect operations may be implemented via programming equipment too.
 Refer to the "Block Protection and Unprotection".
- 4. If WP/ACC=VII., the two outermost boot blocks is protected. If WP/ACC=VIH, the two outermost boot block protection depends on whether those blocks were last protected or unprotected using the method described in "Block Protection and Unprotection". If WP/ACC=VHH, all blocks will be temporarily unprotected.
- Manufacturer and device codes may also be accessed via a command register write sequence. Refer to Table 7.
 Manufacturer and device codes can be read by A22=L only. (Chip1)
- 6. A22 is working as virtual \(\overline{\text{TE}}\) of 2nd chip 1st Chip Enable Condition: \(\overline{\text{CE}}\) - "L", A22 - "L" 2nd Chip Enable Condition: \(\overline{\text{CE}}\) - "L", A22 - "H"



COMMAND DEFINITIONS

The K8Q2815UQB operates by selecting and executing its operational modes. Each operational mode has its own command set. In order to select a certain mode, a proper command with specific address and data sequences must be written into the command register. Writing incorrect information which include address and data or writing an improper command will reset the device to the read mode. The defined valid register command sequences are stated in Table 6. Note that Erase Suspend (B0H) and Erase Resume (30H) commands are valid only while the Block Erase Operation is in progress. Program Suspend (B0H) and Program Resume (30H) commands are valid during Program Operation and Erase Suspend - Program Operation. Only Read Operation is available after Program Suspend Operation. A22 has to be fixed whenever command is issued to the device in order to select one chip of the whole chip. For example, when A22 is Low, 1st chip is selected. And when A22 is High, : 2nd chip is selected.

Table 6. Command Sequences

Command Sequence		Cycle	1st Cycle	2nd Cycle	3rd Cycle	4th Cycle	5th Cycle	6th Cycle
•	Addr		RA	•	,		-	•
Read	Data	1	RD					
	Addr		(See Note13)					
Reset	Data	1	F0H					
Autoselect	Addr		555H	2AAH	DA/555H	DA/X00H		
Manufacturer ID (1,2)	Data	4	AAH	55H	90H	ECH		
Autoselect Device Code	Addr		555H	2AAH	DA/555H	DA/X01H	DA/X0EH	DA/X0FH
(1,2,3)	Data	4	AAH	55H	90H	257EH	2506H	2501H
Autoselect	Addr	_	555H	2AAH	DA/555H	BA / X02H		
Block Protect Verify (1,2)	Data	4	AAH	55H	90H	(See Table 7)		
Autoselect OTP Factory	Addr		555H	2AAH	DA/555H	X03H		
Protect	Data	4	AAH	55H	90H	(See Note 10)		
	Addr		555H	2AAH	555H	PA		
Program	Data	4	AAH	55H	A0H	PD		
	Addr		555H	2AAH	555H			
Unlock Bypass (14)	Data	3	AAH	55H	20H			
Unlock Bypass	Addr		XXXH	PA				
Program (14)	Data	2	A0H	PD				
Unlock Bypass	Addr		XXXH	BA				
Block Erase (14)	Data	2	80H	30H				
Unlock Bypass Chip Erase	Addr		XXXH	XXXH				
(14)	Data	2	80H	10H				
	Addr		XXXH	XXXH				
Unlock Bypass Reset (14)	Data	2	90H	00H				
	Addr		XXH					
Unlock Bypass CFI (14)	Data	1	98H					
	Addr		555H	2AAH	555H	555H	2AAH	555H
Chip Erase	Data	6	AAH	55H	80H	AAH	55H	10H
	Addr		555H	2AAH	555H	555H	2AAH	BA
Block Erase	Data	6	AAH	55H	80H	AAH	55H	30H
Block Erase Suspend	Addr		DA		-		<u> </u>	
(4, 5)	Data	1	ВОН					
	Addr		DA					
Block Erase Resume	Data	1	30H					
	Addr		DA					
Program Suspend (6,7)	Data	1	ВОН					
	Addr		DA					
Program Resume	Data	1	30H					
	Addr		55H					
CFI Query (8)	Data	1	98H					1
	Data		AQH					



Table 6. Command Sequences (Continued)

Command Definitions		Cycle	1st Cycle	2nd Cycle	3rd Cycle	4th Cycle	5th Cycle	6th Cycle
Associated Discours	Addr	0	XXH	PA				
Accelerated Program	Data	2	A0H	PD				
Ouadruple word Assoluted Drawsm/()	Addr	- 5	XXXH	PA1	PA2	PA3	PA4	
Quadruple word Accelerated Program(9)	Data	5	A5H	PD1	PD2	PD3	PD4	
Enter OTD Block Degion (45)	Addr	3	555H	2AAH	555H			
Enter OTP Block Region (15)	Data	3	AAH	55H	88H			
Full OTD Disab Denier (45)	Addr	4	555H	2AAH	555H	XXX		
Exit OTP Block Region (15)	Data	4	AAH	55H	90H	00H		
OTD Danta diam hit Danagara (44, 40, 45)	Addr	6	555H	2AAH	555H	OW	OW	OW
OTP Protection bit Program (11,12,15)	Data	0	AAH	55H	60H	68H	48H	RD(0)
OTD Drataction hit Status (45)	Addr	- 5	555H	2AAH	555H	OW	OW	
OTP Protection bit Status (15)	Data		AAH	55H	60H	48H	RD(0)	

Notes: • RA: Read Address, PA: Program Address, RD: Read Data, PD: Program Data

- DA: Bank Address (A20- A22), BA: Block Address (A12 A22), ABP: Address of the block to be protected or unprotected, X = Don't care.
- OW = Address (A7:A0) is (00011010), RD(0) = Read Data DQ0 for protection indicator bit ,RD(1) = Read Data DQ1 for PPB Lock status.
- DQ8 DQ15 are don't care in command sequence, except for RD and PD.
- A11 A21 are also don't care, except for the case of special notice. (A22 have to be fixed to '0' or '1')
- 1. To terminate the Autoselect Mode, it is necessary to write Reset command to the register.
- 2. The 4th cycle data of Autoselect mode is output data.
 - The 3rd and 4th cycle bank addresses of Autoselect mode must be same.
 - Manufacturer and device codes can be read by A22=L only. (Chip1)
- 3. Device ID must be read across cycles 4, 5 and 6.
- K8Q2815UQB (xOEh = 2506h, x0Fh = 2501h), K8Q2815UQB ID is same with 64Mb ID (K8P6415UQB)
- 4. The Read / Program operations at non-erasing blocks and the autoselect mode are allowed in the Erase Suspend mode.
- 5. The Erase Suspend command is applicable only to the Block Erase operation.
- 6. The Read Operation is allowed in the Program Suspend mode.
- 7. The Program Suspend command is applicable to Program and Erase Suspend Program operation.
- 8. Command is valid when the device is in read mode or Autoselect mode.
 - CFI information can be read by A22=L only. (Chip1)
- Quadruple word accelerated program is invoked only at Vpp=Vid, Vpp setup is required prior to this command sequence. PA1,PA2,PA3,PA4 have the same A22~A2 address
- 10. The data is DQ6=1 for customer locked and DQ7=1 for factory locked.
- 11. Reset command returns device to reading array.
- 12. Cycle 4 programs the addressed locking bit. Cycle 5 and 6 validate bit has been fully programmed when DQ0=1. If DQ0=0 in cycle 6, program command must be issued and verified again.
- 13. All addresses are don't care except A22. A22 has to be fixed to select each chip. (A22 = L : Chip1, A22 = H : Chip2)
- 14. One unlock bypass command is valid on one chip. To enable unlock bypass function in all chips, unlock bypass command should be invoked on each chip.
- 15. OTP block command is valid on chip1 only. (A22 has to be fixed to A22 = L)

Table 7. K8Q2815UQB Autoselect Codes, (High Voltage Method)

D	escription	CE	ŌĒ	WE	A22 to A12	A10	А9	A8	Α7	A6	A5 to A4	А3	A2	A 1	Α0	DQ15 to	DQ7 to DQ0
Manut	facturer ID	L	L	Н	DA	Х	VID	X	L	L	Х	L	L	L	L	Х	ECH
David	Read Cycle 1											L	L	L	Н	25H	7EH
Devi ce ID	Read Cycle 2	L	L	Н	DA	Х	VID	Х	L	L	L	Н	Н	Н	L	25H	06H
	Read Cycle 3											Н	Н	Н	Н	25H	01H
Block ficatio	Protection Veri- n	L	L	Н	ВА	х	VID	Х	L	L	L	L	L	Н	L	Х	01H (Proected) 00H (Unproteced)
OTP I (DQ7.	ndicator Bit DQ6)	L	L	Н	DA	х	VID	Х	х	L	L	L	L	Н	Н	х	DQ7=1(Factory locked) DQ6=1(Customer locked)
	r locking bit tor Bit	L	L	Н	ВА	х	VID	X	L	L	L	L	Н	Н	Н	Х	01H(Pro- tected) 00H (Unproteced)

Notes: 1. L=Logic Low=VIL, H=Logic High=VIH, DA= Bank Address, BA=Block Address, X=Don't care.



DEVICE OPERATION

Read Mode

The K8Q2815UQB is controlled by Chip Enable (\overline{CE}) , Output Enable (\overline{OE}) and Write Enable (\overline{WE}) . When \overline{CE} and \overline{OE} are low and \overline{WE} is high, the data stored at the specified address location, will be the output of the device. The outputs are in high impedance state whenever \overline{CE} or \overline{OE} is high. The K8Q2815UQB is available for Page mode. Page mode provides fast access time for high performance system.

Standby Mode

The K8Q2815UQB features Stand-by Mode to reduce power consumption. This mode puts the device on hold when the device is deselected by making \overline{CE} high $(\overline{CE} = V_{IH})$. Refer to the DC characteristics for more details on stand-by modes.

Output Disable

The device outputs are disabled when \overline{OE} is High $(\overline{OE} = V_{iH})$. The output pins are in high impedance state.

Automatic Sleep Mode

The K8Q2815UQB features Automatic Sleep Mode to minimize the device power consumption. When addresses remain steady for taa+30ns, the device automatically activates the Automatic Sleep Mode. In the sleep mode, output data is latched and always available to the system. When addresses are changed, the device provides new data without wait time.

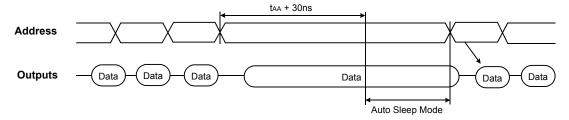


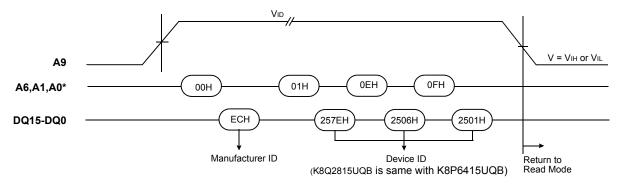
Figure 1. AutoSleep Mode Operation

Autoselect Mode

The K8Q2815UQB offers the Autoselect Mode to identify manufacturer, device type and block protection verification by reading a binary code. The Autoselect Mode allows programming equipment to automatically match the device to be programmed with its corresponding programming algorithm. In addition, this mode allows the verification of the status of write protected blocks. This mode is used by two method. The one is high voltage method to be required V_{ID} (8.5V - 9.5V) on address pin A9. When A9 is held at V_{ID} and the bank address or block address is asserted, the device outputs the valid data via DQ pins(see Table 7 and Figure 2). The rest of addresses except A0, A1 and A6 are don't care. The other is autoselect command method that the autoselect code is accessable by the command sequence without V_{ID} . The manufacturer, device code and block protection verification can be read via the command register. The Command Sequence is shown in Table 7 and Figure 3. The autoselect operation of block protection verification is initiated by first writing two unlock cycle. The third cycle must contain the bank address and autoselect command (90H). If Block address while (A6, A1, A0) = (0,1,0) is finally asserted on the address pin, it will produce a logical "1" at the device output DQ0 to indicate a write protected block or a logical "0" at the device output DQ0 to indicate a write unprotected block. To terminate the autoselect operation, write Reset command (F0H) into the command register.

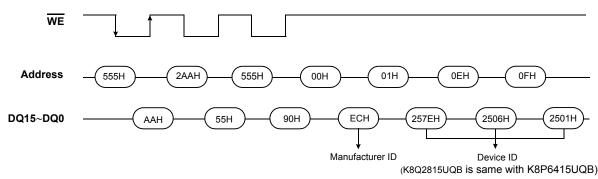
Note that Manufacturer and Device codes in the Autoselect mode can be read by A22=L only. (Chip1)





Note: The addresses other than A0, A1 and A6 are Don't care. Please refer to Table 7 for device code

Figure 2. Autoselect Operation (by High Voltage Method)



Note: The 3rd Cycle and 4th Cycle address must include the same bank address. Please refer to Table 7 for device code.

Figure 3. Autoselect Operation (by Command Sequence Method)

Write (Program/Erase) Mode

The K8Q2815UQB executes its program/erase operations by writing commands into the command register. In order to write the commands to the register, \overline{CE} and \overline{WE} must be low and \overline{OE} must be high. Addresses are latched on the falling edge of \overline{CE} or \overline{WE} (whichever occurs last) and the data are latched on the rising edge of \overline{CE} or \overline{WE} (whichever occurs first). The device uses standard microprocessor write timing.

Program

The K8Q2815UQB can be programmed in units of a word. Programming is writing 0's into the memory array by executing the Internal Program Routine. In order to perform the Internal Program Routine, a four-cycle command sequence is necessary. The first two cycles are unlock cycles. The third cycle is assigned for the program setup command. In the last cycle, the address of the memory location and the data to be programmed at that location are written. The device automatically generates adequate program pulses and verifies the programmed cell margin by the Internal Program Routine. During the execution of the Routine, the system is not required to provide further controls or timings.

During the Internal Program Routine, commands written to the device will be ignored. Note that a hardware reset during a program operation will cause data corruption at the corresponding location.

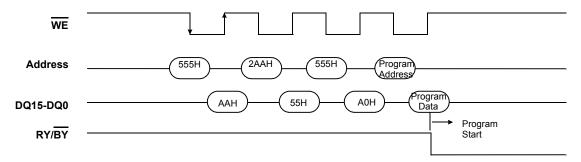


Figure 4. Program Command Sequence



In accross block boundaries and any sequence programming is allowed. A bit cannot be programmed from '0' back to '1'. If attempting to do, it may cause that bank to set DQ5 = 1, or cause the DQ7 and DQ6 status bits to indicate the operation was successful. However, a succeeding read will show that the data is still '0'. Only erase operations can convert a '0' to a '1'.

Unlock Bypass

The K8Q2815UQB provides the unlock bypass mode to save its operation time. This mode is possible for program, block erase and chip erase operation. There are two methods to enter the unlock bypass mode. The mode is invoked by the unlock bypass command sequence. Unlike the standard program/erase command sequence that contains four to six bus cycles, the unlock bypass program/erase command sequence comprises only two bus cycles. The unlock bypass mode is engaged by issuing the unlock bypass command sequence which is comprised of three bus cycles. Writing first two unlock cycles is followed by a third cycle containing the unlock bypass command (20H). Once the device is in the unlock bypass mode, the unlock bypass program/erase command sequence is necessary. The unlock bypass program command sequence is comprised of only two bus cycles; writing the unlock bypass program command (A0H) is followed by the program address and data. This command sequence is the only valid one for programming the device in the unlock bypass mode. Also, The unlock bypass erase command sequence is comprised of two bus cycles; writing the unlock bypass block erase command(80H-30H) or writing the unlock bypass chip erase command(80H-10H). This command sequences are the only valid ones for erasing the device in the unlock bypass mode. The unlock bypass reset command sequence is the only valid command sequence to exit the unlock bypass mode. The unlock bypass reset command sequence consists of two bus cycles. The first cycle must contain the data (90H). The second cycle contains only the data (00H). Then, the device returns to the read mode.

One unlock bypass command is valid on one chip. To enable unlock bypass function in all chips, unlock bypass command should be invoked on each chip.

Chip Erase

To erase a chip is to write 1's into the entire memory array by executing the Internal Erase Routine. The Chip Erase requires six bus cycles to write the command sequence. The erase set-up command is written after first two "unlock" cycles. Then, there are two more write cycles prior to writing the chip erase command. The Internal Erase Routine automatically pre-programs and verifies the entire memory for an all zero data pattern prior to erasing. The automatic erase begins on the rising edge of the last WE or CE pulse in the command sequence and terminates when DQ7 is "1". After that the device returns to the read mode.

The device does not support 'full chip erase'. Only 'half chip erase' by selecting A22 to "0" or "1" is available.

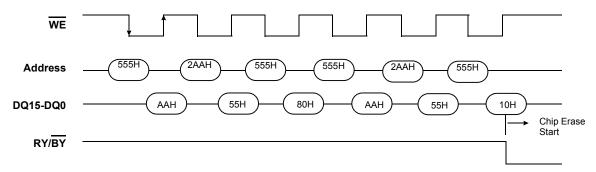


Figure 5. Chip Erase Command Sequence

Block Erase

To erase a block is to write 1's into the desired memory block by executing the Internal Erase Routine. The Block Erase requires six bus cycles to write the command sequence shown in Table 6. After the first two "unlock" cycles, the erase setup command (80H) is written at the third cycle. Then there are two more "unlock" cycles followed by the Block Erase command. The Internal Erase Routine automatically pre-programs and verifies the entire memory prior to erasing it. The block address is latched on the falling edge of $\overline{\text{WE}}$ or $\overline{\text{CE}}$, while the Block Erase command is latched on the rising edge of $\overline{\text{WE}}$ or $\overline{\text{CE}}$.

Multiple blocks can be erased sequentially by writing the six bus-cycle operation in Figure 6. Upon completion of the last cycle for the Block Erase, additional block address and the Block Erase command (30H) can be written to perform the Multi-Block Erase. An 50us (typical) "time window" is required between the Block Erase command writes. The Block Erase command must be written within the 50us "time window", otherwise the Block Erase command will be ignored. The 50us "time window" is reset when the falling edge of the WE occurs within the 50us of "time window" to latch the Block Erase command. During the 50us of "time window", any command other than the Block Erase or the Erase Suspend command written to the device will reset the device to read mode. After the 50 us of "time window", the Block Erase command will initiate the Internal Erase Routine to erase the selected blocks. Any Block Erase address and command following the exceeded "time window" may or may not be accepted. No other commands will be recognized except the Erase Suspend command.

Note : It is not possible to do multi-block erase over two chips. (Chip1 : Bank $0 \sim Bank 3$, Chip2 : Bank $4 \sim Bank 7$)



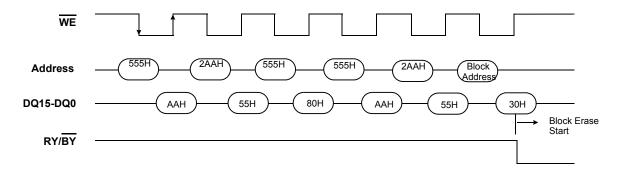


Figure 6. Block Erase Command Sequence

Erase Suspend / Resume

The Erase Suspend command interrupts the Block Erase to read or program data in a block that is not being erased. The Erase Suspend command is only valid during the Block Erase operation including the time window of 50us. The Erase Suspend command is not valid while the Chip Erase or the Internal Program Routine sequence is running.

When the Erase Suspend command is written during a Block Erase operation, the device requires a maximum of 20us to suspend the erase operation. But, when the Erase Suspend command is written during the block erase time window (50us), the device immediately terminates the block erase time window and suspends the erase operation.

After the erase operation has been suspended, the device is available for reading or programming data in a block that is not being erased. The system may also write the autoselect command sequence when the device is in the Erase Suspend mode.

When the Erase Resume command is executed, the Block Erase operation will resume. When the Erase Suspend or Erase Resume command is executed, the addresses are in Don't Care state.

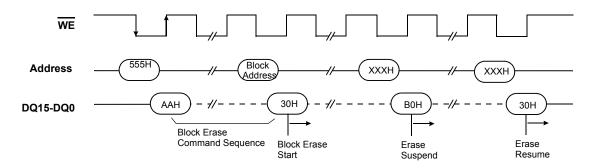


Figure 7. Erase Suspend/Resume Command Sequence

Program Suspend / Resume

The Program Suspend command interrupts the Program operation. Also the Program Suspend command interrupts the Program operation during Erase Suspend Mode. The Read operation is available only during Program Suspend. When the Program Suspend command is written during a Program operation, the device requires a maximum of 10us to suspend the Program operation. The system may also write the autoselect command sequence when the device is in the Program Suspend mode. When the Program Resume command is executed, the Program operation will resume. When the Program Suspend or Program Resume command is executed, the addresses are in Don't Care state.



Read While Write

The K8Q2815UQB provides multi-bank memory architecture that divides the memory array into four banks. The device is capable of reading data from one bank and writing data to the other bank simultaneously. This is so called the Read While Write operation with multi-bank architecture; this feature provides the capability of executing the read operation during Program/Erase or Erase-Suspend-Program operation. The Read While Write operation is prohibited during the chip erase operation. It is also allowed during erase operation when either single block or multiple blocks from same bank are loaded to be erased. It means that the Read While Write operation is prohibited when blocks from one Bank and another blocks from the other Bank are loaded all together for the multi-block erase operation.

Write Protect (WP)

The WP/ACC pin has two useful functions. The one is that certain boot block is protected by the hardware method not to use V_{ID}. The other is that program operation is accelerated to reduce the program time (Refer to Accelerated program Operation Paragraph). When the WP/ACC pin is asserted at V_{IL}, the device can not perform program and erase operation in the two "outermost" 4Kword boot blocks on both ends of the flash array independently of whether those blocks were protected or unprotected using the method described in "Block protection/Unprotection". (BA0 and BA1, BA140 and BA141 for chip1), (BA142 and BA143, BA282 and BA283 for chip2)

The write protected blocks can only be read. This is useful method to preserve an important program data.

When the $\overline{\text{WP}}/\text{ACC}$ pin is asserted at VIH, the device reverts to whether the two outermost 4Kword boot blocks were last set to be protected or unprotected. That is, block protection or unprotection for these two blocks depends on whether they were last protected or unprotected using the method described in "Block protection/unprotection".

Recommend that the WP/ACC pin must not be in the state of floating or unconnected, otherwise the device may be led to malfunction

Software Reset

The reset command provides that the bank is reseted to read mode or erase-suspend-read mode. The addresses are in Don't Care state except A22. A22 has to be fixed to '0' or '1'. The reset command is vaild between the sequence cycles in an erase command sequence before erasing begins, or in a program command sequence before programming begins. This resets the bank in which was operating to read mode. If the device is be erasing or programming, the reset command is invalid until the operation is completed. Also, the reset command is valid between the sequence cycles in an autoselect command sequence. In the autoselect mode, the reset command returns the bank to read mode. If a bank entered the autoselect mode in the Erase Suspend mode, the reset command returns the bank to erase-suspend-read mode. If DQ5 is high on erase or program operation, the reset command return the bank to read mode or erase-suspend-read mode if the bank was in the Erase Suspend state.

Hardware Reset

The K8Q2815UQB offers a reset feature by driving the $\overline{\text{RESET}}$ pin to V_{IL} . The $\overline{\text{RESET}}$ pin must be kept low (V_{IL}) for at least 500ns. When the $\overline{\text{RESET}}$ pin is driven low, any operation in progress will be terminated and the internal state machine will be reset to the standby mode after 20us. If a hardware reset occurs during a program operation, the data at that particular location will be lost. Once the $\overline{\text{RESET}}$ pin is taken high, the device requires 200ns of wake-up time until outputs are valid for read access. Also, note that all the data output pins are tri-stated for the duration of the $\overline{\text{RESET}}$ pulse.

The RESET pin may be tied to the system reset pin. If a system reset occurs during the Internal Program and Erase Routine, the device will be automatically reset to the read mode; this will enable the systems microprocessor to read the boot-up firmware from the Flash memory.



Power-up Protection

To avoid initiation of a write cycle during Vcc Power-up, RESET low must be asserted during power-up. After RESET goes high, the device is reset to the read mode.

Low Vcc Write Inhibit

To avoid initiation of a write cycle during Vcc power-up and power-down, a write cycle is locked out for Vcc less than 2.3V. If Vcc < Vlko (Lock-Out Voltage), the command register and all internal program/erase circuits are disabled. Under this condition the device will reset itself to the read mode. Subsequent writes will be ignored until the Vcc level is greater than Vlko. It is the user's responsibility to ensure that the control pins are logically correct to prevent unintentional writes when Vcc is above 2.3V.

Write Pulse Glitch Protection

Noise pulses of less than 5ns(typical) on \overline{CE} , \overline{OE} , or \overline{WE} will not initiate a write cycle.

Logical Inhibit

Writing is inhibited under any one of the following conditions : $\overline{OE} = V_{IL}$, $\overline{CE} = V_{IH}$ or $\overline{WE} = V_{IH}$. To initiate a write, \overline{CE} and \overline{WE} must be "0", while \overline{OE} is "1".

Commom Flash Memory Interface

Common Flash Momory Interface is contrived to increase the compatibility of host system software. It provides the specific information of the device, such as memory size, word configuration, and electrical features. Once this information has been obtained, the system software will know which command sets to use to enable flash writes, block erases, and control the flash component. When the system writes the CFI command(98H) to address 55H in word mode, the device enters the CFI mode. And then if the system writes the address shown in Table 11, the system can read the CFI data. Query data are always presented on the lowest-order data outputs(DQ0-7) only. In word(x16) mode, the upper data outputs(DQ8-15) is 00h. To terminate this operation, the system must write the reset command.

Note that CFI information can be read by A22=L only. (Chip1)

OTP Block Region

The OTP Block feature provides a 256-word Flash memory region that enables permanent part identification through an Electronic Serial Number (ESN). The OTP Block is customer lockable and shipped with itself unlocked, allowing customers to untilize the that block in any manner they choose. Indicator bits DQ6 and DQ7 are used to indicate the factory-locked and customer locked status of the part. The data is DQ6 = "1" for customer locked and DQ7 = "1" for factory locked.

The system accesses the OTP Block through a command sequence (see "Enter OTP Block / Exit OTP Block Command sequence" at Table 6). After the system has written the "Enter OTP Block" Command sequence, it may read the OTP Block by using the addresses (000000h~0000FFh) normally and may check the Protection Verify Bit (DQ7,DQ6) by using the "Autoselect Block Protection Verify" Command sequence with OTP Block address. This mode of operation continues until the system issues the "Exit OTP Block" Command suquence, a hardware reset or until power is removed from the device. On power-up, or following a hardware reset, the device reverts to sending commands to main blocks. Note that the Accelerated function and unlock bypass modes are not available when the OTP Block is enabled.

Customer Lockable

In a Customer lockable device, The OTP Block is one-time programmable and can be locked only once. Note that the Accelerated programming and Unlock bypass functions are not available when programming the OTP Block. Locking operation to the OTP Block is started by writing the "Enter OTP Block" Command sequence, and it can be permanently locked to "1" by issuing the OTP Protection bit program Command squence. Once the OTP block is locked and verified, the system must write the Exit OTP block command to return to reading and writing the remainder of the array.

OTP Protection Bits

OTP protection bits prevent programming of the OTP block memory area. Once set, the OTP area are non-modifiable.

- The OTP Block Lock operation must be used with caution since, once locked, there is no procedure available for unlocking and none of the bits in the OTP Block space can be modified in any way.
- Suspend and resume operation are not supported during OTP protect, nor is OTP protect supported during any suspend operation.



High Voltage Block Protection

Block protection and unprotection may also be implemented using programming equipment. The procedure requires high voltage (Vid) to be placed on the RESET# pin. Refer to Figure 8 for details on this procedure. Note that for block unprotect, all unprotected blocks must first be protected prior to the first sector write cycle.

Accelerated Program Operation

Accelerated program operation is one of two functions provided by the $\overline{\text{WP}}/\text{ACC}$ pin. When the $\overline{\text{WP}}/\text{ACC}$ pin is asserted as VHH, the device automatically enters the Unlock Bypass mode, temporarily unprotecting any protected blocks. The <u>system</u> would use a two-cycle program command sequence as required by the Unlock Bypass mode. Removing VHH from the $\overline{\text{WP}}/\text{ACC}$ pin returns the device to normal operation.

Recommend that the WP/ACC pin must not be asserted at VhH except on accelerated program operation, or the device may be damaged. In addition, the WP/ACC pin must not be in the state of floating or unconnected, otherwise the device may be led to malfunction.

Single word accelerated program operation

The system would use two-cycle program sequence (One-cycle (XXX - A0H) is for single word program command, and Next one-cycle (PA - PD) is for program address and data).

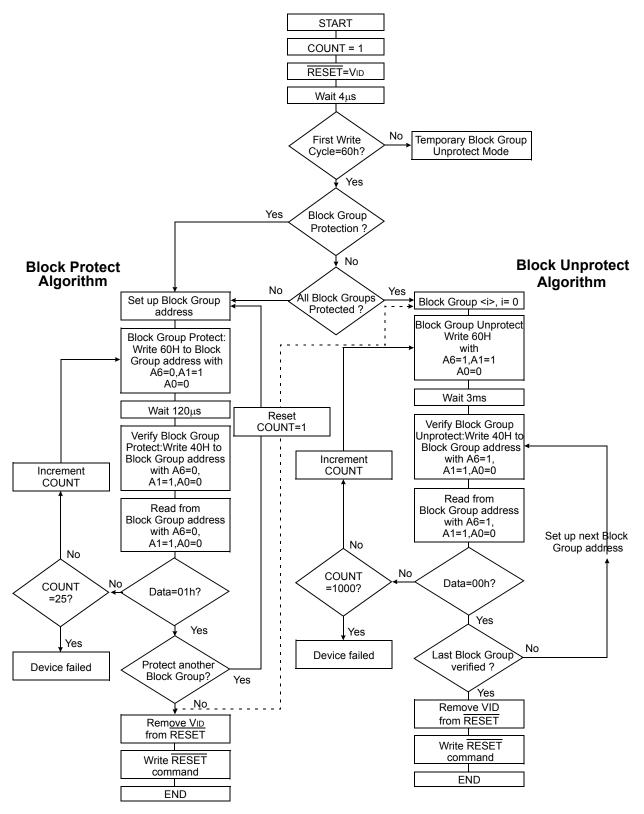
Quadruple word accelerated program operation

As well as Single word accelerated program, the system would use five-cycle program sequence (One-cycle (XXX - A5H) is for quadruple word program command, and four cycles are for program address and data).

- Only four words programming is possible
- Each program address must have the same A22~A2 address
- · The device automatically generates adequate program pulses and ignores other command after program command
- Program/Erase cycling must be limited below 100cycles for optimum performance.
- · Read while Write mode is not guaranteed

Requirements : Ambient temperature : Ta=30°C±10°C





Note: All blocks must be protected before unprotect operation is executing.

Figure 8. Block Group Protection & Unprotection Algorithms



Table 8. Block Protection Schemes

DYB	PPB	PPB Lock	Block State
0	0	0	Unprotected-PPB and DYB are changeable
0	0	1	Unprotected-PPB not changeable and DYB are changeable
0	1	0	
1	0	0	Protected-PPB and DYB are changeable
1	1	0	
0	1	1	Protected-PPB not changeable, DYB is changeable
1	0	1	
1	1	1	

Block Protection

The K8Q2815UQB features several levels of block protection, which can disable both the program and erase operations in certain blocks or block groups:

Persistent Block Protection

A command block protection method that replaces the old 12 V controlled protection method.

Password Block Protection

A highly sophisticated protection method that requires a password before changes to certain blocks or block groups are permitted

Selecting a Block Protection Mode

All parts default to operate in the Persistent Block Protection mode. The customer must then choose if the Persistent or Password Protection method is most desirable. There are two one-time programmable non-volatile bits that define which block protection-method will be used. If the Persistent Block Protection method is desired, programming the Persistent Block Protection Mode Locking Bit permanently sets the device to the Persistent Block Protection mode. If the Password Block Protection method is desired, programming the Password Mode Locking Bit permanently sets the device to the Password Block Protection mode. It is not possible to switch between the two protection modes once a locking bit has been set. One of the two modes must be selected when the device is first programmed. This prevents a program or virus from later setting the Password Mode Locking Bit, which would cause an unexpected shift from the default Persistent Block Protection Mode into the Password Protection Mode. The device is shipped with all blocks unprotected. Optional Samsung programming services enable programming and protecting blocks at the factory prior to shipping the device. Contact your local sales office for details.

It is possible to determine whether a block is protected or unprotected. See Autoselect Mode for details.

Persistent Block Protection

The Persistent Block Protection method replaces the 12 V controlled protection method in previous flash devices. This new method provides three different block protection states:

Persistently Locked - The block is protected and cannot be changed.

Dynamically Locked - The block is protected and can be changed by a simple command.

Unlocked - The block is unprotected and can be changed by a simple command.

To achieve these states, three types of "bits" are used:

Persistent Protection Bit

Persistent Protection Bit Lock

Persistent Block Protection Mode Locking Bit

Persistent Protection Bit (PPB)

A single Persistent (non-volatile) Protection Bit is assigned to a maximum four blocks (see the block address tables for specific block protection groupings). All 4 Kword boot-block sectors have individual block Persistent Protection Bits(PPBs) for greater flexibility. Each PPB is individually modifiable through the PPB Write Command.



The device erases all PPBs in parallel. If any PPB requires erasure, the device must be instructed to preprogram all of the block PPBs prior to PPB erasure. Otherwise, a previously erased block PPBs can potentially be over-erased. The flash device does not have a built-in means of preventing block PPBs over-erasure.

Persistent Protection Bit Lock (PPB Lock)

The Persistent Protection Bit Lock (PPB Lock) is a global volatile bit. When set to "1", the PPBs cannot be changed. When cleared "0", the PPBs are changeable. There is only one PPB Lock bit per device. The PPB Lock is cleared after power-up or hardware reset. There is no command sequence to unlock the PPB Lock.

Dynamic Protection Bit (DYB)

A volatile protection bit is assigned for each block. After power-up or hardware reset, the contents of all DYBs is "0". Each DYB is individually modifiable through the DYB Write Command.

When the parts are first shipped, the PPBs are cleared, the DYBs are cleared, and PPB Lock is defaulted to power up in the cleared state - meaning the PPBs are changeable. When the device is first powered on the DYBs power up cleared (blocks not protected). The Protection State for each sector is determined by the logical OR of the PPB and the DYB related to that block. For the blocks that have the PPBs cleared, the DYBs control whether or not the block is protected or unprotected.

By issuing the DYB Write command sequences, the DYBs will be set or cleared, thus placing each block in the protected or unprotected state. These are the so-called Dynamic Locked or Unlocked states. They are called dynamic states because it is very easy to switch back and forth between the protected and unprotected conditions. This allows software to easily protect blocks against inadvertent changes yet does not prevent the easy removal of protection when changes are needed. The DYBs maybe set or cleared as often as needed.

The PPBs allow for a more static, and difficult to change, level of protection. The PPBs retain their state across power cycles because they are non-volatile. Individual PPBs are set with a command but must all be cleared as a group through a complex sequence of program and erasing commands. The PPBs are also limited to 100 erase cycles.

The PPB Lock bit adds an additional level of protection. Once all PPBs are programmed to the desired settings, the PPB Lock may be set to "1". Setting the PPB Lock disables all program and erase commands to the non-volatile PPBs. In effect, the PPB Lock Bit locks the PPBs into their current state. The only way to clear the PPB Lock is to go through a power cycle. System boot code can determine if any changes to the PPB are needed; for example, to allow new system code to be downloaded. If no changes are needed then the boot code can set the PPB Lock to disable any further changes to the PPBs during system operation.

The WP#/ACC write protect pin adds a final level of hardware protection to blocks BA269 and BA268, BA0 and BA1. When this pin is low it is not possible to change the contents of these blocks. These blocks generally hold system boot code. The WP#/ACC pin can prevent any changes to the boot code that could override the choices made while setting up block protection during system initialization

For customers who are concerned about malicious viruses there is another level of security - the persistently locked state. To persistently protect a given block or block group, the PPBs associated with that block need to be set to "1". Once all PPBs are programmed to the desired settings, the PPB Lock should be set to "1". Setting the PPB Lock automatically disables all program and erase commands to the Non-Volatile PPBs. In effect, the PPB Lock "freezes" the PPBs into their current state. The only way to clear the PPB Lock is to go through a power cycle.

It is possible to have blocks that have been persistently locked, and blocks that are left in the dynamic state. The blocks in the dynamic state are all unprotected. If there is a need to protect some of them, a simple DYB Write command sequence is all that is necessary. The DYB write command for the dynamic blocks switch the DYBs to signify protected and unprotected, respectively. If there is a need to change the status of the persistently locked blocks, a few more steps are required. First, the PPB Lock bit must be disabled by either putting the device through a power-cycle, or hardware reset. The PPBs can then be changed to reflect the desired settings. Setting the PPB lock bit once again will lock the PPBs, and the device operates normally again.

The best protection is achieved by executing the PPB lock bit set command early in the boot code, and protect the boot code by holding WP#/ACC = VIL.

Table 8 contains all possible combinations of the DYB, PPB, and PPB lock relating to the status of the block.

In summary, if the PPB is set, and the PPB lock is set, the block is protected and the protection can not be removed until the next power cycle clears the PPB lock. If the PPB is cleared, the block can be dynamically locked or unlocked. The DYB then controls whether or not the block is protected or unprotected.



If the user attempts to program or erase a protected block, the device ignores the command and returns to read mode. A program command to a protected block enables status polling for approximately 1us before the device returns to read mode without having modified the contents of the protected block. An erase command to a protected block enables status polling for approximately 50us after which the device returns to read mode without having erased the protected block.

The programming of the DYB, PPB, and PPB lock for a given block can be verified by writing a DYB/PPB/PPB lock verify command to the device.

Persistent Block Protection Mode Locking Bit

Like the password mode locking bit, a Persistent Block Protection mode locking bit exists to guarantee that the device remain in software block protection. Once set, the Persistent Block Protection locking bit prevents programming of the password protection mode locking bit. This guarantees that a hacker could not place the device in password protection mode.

Password Protection Mode

The Password Block Protection Mode method allows an even higher level of security than the Persistent Block Protection Mode. There are two main differences between the Persistent Block Protection and the Password Block Protection Mode:

When the device is first powered on, or comes out of a reset cycle, the PPB Lock bit set to the locked state, rather than cleared to the unlocked state.

The only means to clear the PPB Lock bit is by writing a unique 64-bit Password to the device.

The Password Block Protection method is otherwise identical to the Persistent Block Protection method.

A 64-bit password is the only additional tool utilized in this method.

Once the Password Mode Locking Bit is set, the password is permanently set with no means to read, program, or erase it. The password is used to clear the PPB Lock bit. The Password Unlock command must be written to the flash, along with a password. The flash device internally compares the given password with the pre-programmed password. If they match, the PPB Lock bit is cleared, and the PPBs can be altered. If they do not match, the flash device does nothing. There is a built-in 2us delay for each "password check." This delay is intended to thwart any efforts to run a program that tries all possible combinations in order to crack the password.

Password and Password Mode Locking Bit

In order to select the Password block protection scheme, the customer must first program the password. The password may be correlated to the unique Electronic Serial Number (ESN) of the particular flash device. Each ESN is different for every flash device; therefore each password should be different for every flash device. While programming in the password region, the customer may perform Password Verify operations.

Once the desired password is programmed in, the customer must then set the Password Mode Locking Bit. This operation achieves two objectives:

Permanently sets the device to operate using the Password Protection Mode. It is not possible to reverse this function. Disables all further commands to the password region. All program, and read operations are ignored.

Both of these objectives are important, and if not carefully considered, may lead to unrecoverable errors. The user must be sure that the Password Protection method is desired when setting the Password Mode Locking Bit. More importantly, the user must be sure that the password is correct when the Password Mode Locking Bit is set. Due to the fact that read operations are disabled, there is no means to verify what the password is afterwards. If the password is lost after setting the Password Mode Locking Bit, there will be no way to clear the PPB Lock bit.

The Password Mode Locking Bit, once set, prevents reading the 64-bit password on the DQ bus and further password programming. The Password Mode Locking Bit is not erasable. Once Password Mode Locking Bit is programmed, the Persistent Block Protection Locking Bit is disabled from programming, guaranteeing that no changes to the protection scheme are allowed.

64-bit Password

The 64-bit Password is located in its own memory space and is accessible through the use of the Password Program and Verify commands (see "Password Verify Command"). The password function works in conjunction with the Password Mode Locking Bit, which when set, prevents the Password Verify command from reading the contents of the password on the pins of the device.

Write Protect (WP#)

The Write Protect feature provides a hardware method of protecting the upper two and lower two blocks without using VID. This function is provided by the WP# pin and overrides the previously discussed "High Voltage Block Protection" section method.



If the system asserts VIL on the WP#/ACC pin, the device disables program and erase functions in the two outermost 4 Kword blocks on both ends of the flash array independent of whether it was previously protected or unprotected.

If the system asserts VIH on the WP#/ACC pin, the device reverts the upper two and lower two blocks to whether they were last set to be protected or unprotected. That is, block protection or unprotection for these sectors depends on whether they were last protected or unprotected using the method described in the "High Voltage Block Protection" section.

Persistent Protection Bit Lock

The Persistent Protection Bit (PPB) Lock is a volatile bit that reflects the state of the Password Mode Locking Bit after power-up reset. If the Password Mode Lock Bit is also set after a hardware reset (RESET# asserted) or a power-up reset, the ONLY means for clearing the PPB Lock Bit in Password Protection Mode is to issue the Password Unlock command. Successful execution of the Password Unlock command clears the PPB Lock Bit, allowing for block PPBs modifications. Asserting RESET#, taking the device through a power-on reset, or issuing the PPB Lock Bit Set command sets the PPB Lock Bit to a "1" when the Password Mode Lock Bit is not set.

If the Password Mode Locking Bit is not set, including Persistent Protection Mode, the PPB Lock Bit is cleared after power-up or hardware reset. The PPB Lock Bit is set by issuing the PPB Lock Bit Set command. Once set the only means for clearing the PPB Lock Bit is by issuing a hardware or power-up reset. The Password Unlock command is ignored in Persistent Protection Mode.

Master locking bit set

This Master locking bit can ensure that protected blocks be permanently unalterable.

Master locking bit is non-volatile bit. Master locking bit controls protection status of entire blocks.

The usage of the master locking bit command sequence is absolutely required to ensure full protection of data from future alterations. If master locking bit is set ("1"), entire blocks are permanently protected. They are not changed and altered by any future lock/unlock commands.

Anyone who uses this fuction needs much attention. Because there is no way to return to unlock status. Default status of master locking bit is unlock status("0").

If Master locking bit sets on unprotected block, the block still are remaining in status of unprotected block.

The unprotected block can be protected by protection command.

Note: If user wants to use Password mode / Master locking bit function / PPB lock bit function, it is needed to be set it on each chip.



Table 9. K8Q28K8Q2815UQB Boot Block/Block Addresses for Protection / Unprotection (Chip1, A22='0')

BAD	Block	A22-A12	Block Size
BA2 0000000010	BA0	0000000000	4 Kwords
BA3	BA1	000000001	4 Kwords
BA4 0000000100	BA2	0000000010	4 Kwords
BA4 0000000100	BA3	0000000011	4 Kwords
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BA51-BA54 001011XXXXX 128 (4x32) Kwords BA55-BA58 001100XXXXX 128 (4x32) Kwords BA59-BA62 001101XXXXX 128 (4x32) Kwords BA63-BA66 001110XXXXX 128 (4x32) Kwords BA67-BA70 001111XXXXX 128 (4x32) Kwords BA71-BA74 010000XXXXX 128 (4x32) Kwords BA75-BA78 010001XXXXX 128 (4x32) Kwords BA79-BA82 010010XXXXX 128 (4x32) Kwords BA83-BA86 010011XXXXX 128 (4x32) Kwords BA87-BA90 010100XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 01100XXXXX 128 (4x32) Kwords BA11-BA114 01100XXXXX 128 (4x32) Kwords BA11-BA114 01101XXXXX 128 (4x32) Kwords BA119-BA122 01110XXXXX 128 (4x32) Kwords BA119-BA126 01110XXXXX 128 (4x32) Kwords BA131 011110XXXXX	BA43-BA46	001001XXXXX	128 (4x32) Kwords
BA55-BA58 001100XXXXX 128 (4x32) Kwords BA59-BA62 001101XXXXX 128 (4x32) Kwords BA63-BA66 001110XXXXX 128 (4x32) Kwords BA67-BA70 001111XXXXX 128 (4x32) Kwords BA71-BA74 010000XXXXX 128 (4x32) Kwords BA71-BA74 010000XXXXX 128 (4x32) Kwords BA75-BA78 010001XXXXX 128 (4x32) Kwords BA79-BA82 010010XXXXX 128 (4x32) Kwords BA83-BA86 010011XXXXX 128 (4x32) Kwords BA87-BA90 010100XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 01100XXXXX 128 (4x32) Kwords BA107-BA110 01100XXXXX 128 (4x32) Kwords BA111-BA114 01101XXXXX 128 (4x32) Kwords BA111-BA114 01101XXXXX 128 (4x32) Kwords BA111-BA114 01101XXXXX 128 (4x32) Kwords BA111-BA116 01101XXXXX 128 (4x32) Kwords BA111-BA117 01110XXXXX 128 (4x32) Kwords BA111-BA118 01101XXXXX 128 (4x32) Kwords BA112-BA130 01110XXXXX 128 (4x32) Kwords BA131 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 128 (4x32) Kwords BA132 0111110XXXX 128 (4x32) Kwords	BA47-BA50	001010XXXXX	128 (4x32) Kwords
BA59-BA62 001101XXXXX 128 (4x32) Kwords BA63-BA66 001110XXXXX 128 (4x32) Kwords BA67-BA70 001111XXXXX 128 (4x32) Kwords BA71-BA74 010000XXXXX 128 (4x32) Kwords BA75-BA78 010001XXXXX 128 (4x32) Kwords BA79-BA82 010010XXXXX 128 (4x32) Kwords BA83-BA86 010011XXXXX 128 (4x32) Kwords BA87-BA90 010100XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA11-BA110 011001XXXXX 128 (4x32) Kwords BA11-BA114 011010XXXXX 128 (4x32) Kwords BA119-BA122 01110XXXXX 128 (4x32) Kwords BA119-BA120 011101XXXXX 128 (4x32) Kwords BA123-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords	BA51-BA54	001011XXXXX	128 (4x32) Kwords
BA63-BA66 001110XXXXX 128 (4x32) Kwords BA67-BA70 001111XXXXX 128 (4x32) Kwords BA71-BA74 010000XXXXX 128 (4x32) Kwords BA75-BA78 010001XXXXX 128 (4x32) Kwords BA79-BA82 010010XXXXX 128 (4x32) Kwords BA83-BA86 010011XXXXX 128 (4x32) Kwords BA87-BA90 010100XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA12-BA126 011100XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords BA132 0111110XXX 32 Kwords BA133 01111110XXX 32 Kwords	BA55-BA58	001100XXXXX	128 (4x32) Kwords
BA67-BA70 001111XXXXX 128 (4x32) Kwords BA71-BA74 010000XXXXX 128 (4x32) Kwords BA75-BA78 010001XXXXX 128 (4x32) Kwords BA79-BA82 010010XXXXX 128 (4x32) Kwords BA83-BA86 010011XXXXX 128 (4x32) Kwords BA87-BA90 010100XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA131 011110XXXX 32 Kwords BA132 0111110XXX 32 Kwords BA133 0111110XXX 32 Kwords	BA59-BA62	001101XXXXX	128 (4x32) Kwords
BA71-BA74 010000XXXXX 128 (4x32) Kwords BA75-BA78 010001XXXXX 128 (4x32) Kwords BA79-BA82 010010XXXXX 128 (4x32) Kwords BA83-BA86 010011XXXXX 128 (4x32) Kwords BA87-BA90 010100XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 0111110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 128 (4x32) Kwords BA132 0111110XXXX 128 (4x32) Kwords	BA63-BA66	001110XXXXX	128 (4x32) Kwords
BA75-BA78 010001XXXXX 128 (4x32) Kwords BA79-BA82 010010XXXXX 128 (4x32) Kwords BA83-BA86 010011XXXXX 128 (4x32) Kwords BA87-BA90 010100XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA131 011110XXXXX 128 (4x32) Kwords BA131 011110XXXXX 128 (4x32) Kwords BA132 0111110XXXX 32 Kwords	BA67-BA70	001111XXXXX	128 (4x32) Kwords
BA79-BA82 010010XXXXX 128 (4x32) Kwords BA83-BA86 010011XXXXX 128 (4x32) Kwords BA87-BA90 010100XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXXX 32 Kwords BA132 0111110XXXX 32 Kwords BA133 01111110XXX 32 Kwords	BA71-BA74	010000XXXXX	128 (4x32) Kwords
BA83-BA86 010011XXXXX 128 (4x32) Kwords BA87-BA90 010100XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords BA132 0111110XXXX 32 Kwords BA133 01111110XXX 32 Kwords	BA75-BA78	010001XXXXX	128 (4x32) Kwords
BA87-BA90 010100XXXXX 128 (4x32) Kwords BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords BA132 0111110XXXX 32 Kwords BA133 01111110XXX 32 Kwords	BA79-BA82	010010XXXXX	128 (4x32) Kwords
BA91-BA94 010101XXXXX 128 (4x32) Kwords BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords BA132 0111110XXXX 32 Kwords BA133 0111110XXXX 32 Kwords	BA83-BA86	010011XXXXX	128 (4x32) Kwords
BA95-BA98 010110XXXXX 128 (4x32) Kwords BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords BA132 0111110XXX 32 Kwords BA133 01111110XXX 32 Kwords	BA87-BA90	010100XXXXX	128 (4x32) Kwords
BA99-BA102 010111XXXXX 128 (4x32) Kwords BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords BA132 0111110XXXX 32 Kwords BA133 0111110XXXX 32 Kwords	BA91-BA94	010101XXXXX	128 (4x32) Kwords
BA103-BA106 011000XXXXX 128 (4x32) Kwords BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords BA132 0111110XXX 32 Kwords BA133 0111110XXX 32 Kwords	BA95-BA98	010110XXXXX	128 (4x32) Kwords
BA107-BA110 011001XXXXX 128 (4x32) Kwords BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 011110XXXX 32 Kwords BA132 0111110XXX 32 Kwords BA133 0111110XXX 32 Kwords	BA99-BA102	010111XXXXX	128 (4x32) Kwords
BA111-BA114 011010XXXXX 128 (4x32) Kwords BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords BA132 01111101XXX 32 Kwords BA133 01111110XXX 32 Kwords	BA103-BA106	011000XXXXX	128 (4x32) Kwords
BA115-BA118 011011XXXXX 128 (4x32) Kwords BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords BA132 01111101XXX 32 Kwords BA133 01111110XXX 32 Kwords	BA107-BA110	011001XXXXX	128 (4x32) Kwords
BA119-BA122 011100XXXXX 128 (4x32) Kwords BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXXX 32 Kwords BA132 01111101XXX 32 Kwords BA133 01111110XXX 32 Kwords	BA111-BA114	011010XXXXX	128 (4x32) Kwords
BA123-BA126 011101XXXXX 128 (4x32) Kwords BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 0111110XXX 32 Kwords BA132 01111101XXX 32 Kwords BA133 01111110XXX 32 Kwords	BA115-BA118	011011XXXXX	128 (4x32) Kwords
BA127-BA130 011110XXXXX 128 (4x32) Kwords BA131 01111100XXX 32 Kwords BA132 01111101XXX 32 Kwords BA133 01111110XXX 32 Kwords	BA119-BA122	011100XXXXX	128 (4x32) Kwords
BA131 01111100XXX 32 Kwords BA132 01111101XXX 32 Kwords BA133 01111110XXX 32 Kwords	BA123-BA126	011101XXXXX	128 (4x32) Kwords
BA132 01111101XXX 32 Kwords BA133 01111110XXX 32 Kwords	BA127-BA130	011110XXXXX	128 (4x32) Kwords
BA133 01111110XXX 32 Kwords	BA131	01111100XXX	32 Kwords
	BA132	01111101XXX	32 Kwords
	BA133	01111110XXX	32 Kwords
■ DA 134 UTTTTTTUUU 4 KWOrds	BA134	01111111000	4 Kwords
BA135 01111111001 4 Kwords			



Table 9. K8Q2815UQB Boot Block/Block Addresses for Protection / Unprotection (Continued) (Chip1, A22='0')

Block	A22-A12	Block Size
BA136	01111111010	4 Kwords
BA137	0111111011	4 Kwords
BA138	01111111100	4 Kwords
BA139	0111111101	4 Kwords
BA140	0111111110	4 Kwords
BA141	0111111111	4 Kwords

Table 9. K8Q2815UQB Boot Block/Block Addresses for Protection / Unprotection (Chip2, A22='1')

Block	A22-A12	Block Size
BA142	100000000	4 Kwords
BA143	1000000001	4 Kwords
BA144	1000000010	4 Kwords
BA145	1000000011	4 Kwords
BA146	1000000100	4 Kwords
BA140	10000000100	4 Kwords
BA148	1000000110	4 Kwords
BA149	1000000111	4 Kwords
BA150	10000001XXX	32 Kwords
BA151	10000010XXX	32 Kwords
BA152	10000011XXX	32 Kwords
BA153-BA156	100001XXXXX	128 (4x32) Kwords
BA157-BA160	100010XXXXX	128 (4x32) Kwords
BA161-BA164	100011XXXXX	128 (4x32) Kwords
BA165-BA168	100100XXXXX	128 (4x32) Kwords
BA169-BA172	100101XXXXX	128 (4x32) Kwords
BA173-BA176	100110XXXXX	128 (4x32) Kwords
BA177-BA180	100111XXXXX	128 (4x32) Kwords
BA181-BA184	101000XXXXX	128 (4x32) Kwords
BA185-BA188	101001XXXXX	128 (4x32) Kwords
BA189-BA192	101010XXXXX	128 (4x32) Kwords
BA193-BA196	101011XXXXX	128 (4x32) Kwords
BA197-BA200	101100XXXXX	128 (4x32) Kwords
BA201-BA204	101101XXXXX	128 (4x32) Kwords
BA205-BA208	101110XXXXX	128 (4x32) Kwords
BA209-BA212	101111XXXXX	128 (4x32) Kwords
BA213-BA216	110000XXXXX	128 (4x32) Kwords
BA217-BA220	110001XXXXX	128 (4x32) Kwords
BA221-BA224	110010XXXXX	128 (4x32) Kwords
BA225-BA228	110011XXXXX	128 (4x32) Kwords
BA229-BA132	110100XXXXX	128 (4x32) Kwords
BA233-BA236	110101XXXXX	128 (4x32) Kwords
BA237-BA240	110110XXXXX	128 (4x32) Kwords
BA241-BA244	110111XXXXX	128 (4x32) Kwords
BA245-BA248	111000XXXXX	128 (4x32) Kwords
BA249-BA252	111001XXXXX	128 (4x32) Kwords
BA253-BA256	111010XXXXX	128 (4x32) Kwords
BA257-BA260	111011XXXXX	128 (4x32) Kwords
BA261-BA264	111100XXXXX	128 (4x32) Kwords
BA265-BA268	111101XXXXX	128 (4x32) Kwords
BA269-BA272	111110XXXXX	128 (4x32) Kwords
BA273	11111100XXX	32 Kwords
BA274	11111101XXX	32 Kwords
BA275	11111110XXX	32 Kwords
BA276	11111111000	4 Kwords
BA277	11111111001	4 Kwords



Table 9. K8Q2815UQB Boot Block/Block Addresses for Protection / Unprotection (Continued) (Chip2, A22='1')

Block	A22-A12	Block Size
BA278	1111111010	4 Kwords
BA279	1111111011	4 Kwords
BA280	1111111100	4 Kwords
BA281	1111111101	4 Kwords
BA282	1111111110	4 Kwords
BA283	1111111111	4 Kwords

Table 10. Block Protection Command Sequences

Command Sequence		Cycl	1st Cycle	2nd Cycle	3rd Cycle	4th Cycle	5th Cycle	6th Cycle	7th Cycle
December December (4.0)	Addr	4	555H	2AAH	555H	XX[0-3]H			
Password Program(1,2)	Data	4	AAH	55H	38H	PD[0-3]			
D 114 15 (0.4 =)	Addr	4	555H	2AAH	555H	PWA[0-3]			
Password Verify(2,4,5)	Data	4	AAH	55H	C8H	PWD[0-3]			
Password Unlock(3,6,7)	Addr	7	555H	2AAH	555H	PWA[0]	PWA[1]	PWA[2]	PWA[3]
Password Officek(3,0,7)	Data	,	AAH	55H	28H	PWD[0]	PWD[1]	PWD[2]	PWD[3]
DDD D(4 0 0)	Addr	6	555H	2AAH	555H	(BA)WP	(BA)WP	(BA)WP	
PPB Program(1,2,8)	Data	0	AAH	55H	60H	68H	48H	RD(0)	
Master locking bit Set	Addr	3	555H	2AAH	555H				
Master locking bit set	Data	3	AAH	55H	F1H				
PPB Status	Addr	4	555H	2AAH	555H	(BA)WP			
FFB Status	Data	4	AAH	55H	90H	RD(0)			
All DDD Franc(4.2.0.40)	Addr	6	555H	2AAH	555H	WP	(BA)	(BA)WP	
All PPB Erase(1,2,9,10)	Data	0	AAH	55H	60H	60H	40H	RD(0)	
DDD Lock Bit Oct	Addr		555H	2AAH	555H				
PPB Lock Bit Set	Data	3	AAH	55H	78H				
PPP 1 1 PV 01 1 (11)	Addr		555H	2AAH	555H	BA			
PPB Lock Bit Status(11)	Data	4	AAH	55H	58H	RD(1)			
DVD Weit (0)	Addr		555H	2AAH	555H	BA			
DYB Write(3)	Data	4	AAH	55H	48H	X1H			
D)/D =(0)	Addr		555H	2AAH	555H	BA			
DYB Erase(3)	Data	4	AAH	55H	48H	X0H			
D)/D 0(-1 - /0)	Addr		555H	2AAH	(DA)555H	BA			
DYB Status(2)	Data	4	AAH	55H	58H	RD(0)			
DD141 D D (4.0.0)	Addr	_	555H	2AAH	555H	PL	PL	PL	
PPMLB Program(1,2,8)	Data	6	AAH	55H	60H	68H	48H	RD(0)	
	Addr	_	555H	2AAH	555H	PL	PL		
PPMLB Status(1)	Data	- 5	AAH	55H	60H	48H	RD(0)		
ODIN D D (4.5.5)	Addr		555H	2AAH	555H	BL	BL	BL	
SPMLB Program(1,2,8)	Data	6	AAH	55H	60H	68	48	RD(0)	
	Addr		555H	2AAH	555H	BL	BL		
SPMLB Status(1)	Data	- 5	AAH	55H	60H	48	RD(0)		

Legend:

DYB = Dynamic Protection Bit

OW = Address (A7:A0) is (00011010)

PD[3:0] = Password Data (1 of 4 portions)

PPB = Persistent Protection Bit

PWA = Password Address. A1:A0 selects portion of password.

PWD = Password Data being verified.

PL = Password Protection Mode Lock Address (A7:A0) is (00001010)

RD(0) = Read Data DQ0 for protection indicator bit.

RD(1) = Read Data DQ1 for PPB Lock status.

BA = Block Address where security command applies. Address bits Amax:A12 uniquely select any block.

BL = Persistent Protection Mode Lock Address (A7:A0) is (00010010)

WP = PPB Address (A7:A0) is (00000010)

X = Don't care

PPMLB = Password Protection Mode Locking Bit

SPMLB = Persistent Protection Mode Locking Bit



Notes:

- See the description of bus operations.
- All values are in hexadecimal.
- Shaded cells in table denote read cycles. All other cycles are write operations.
- During unlock and command cycles, when lower address bits are 555 or 2AAh as shown in table, address bits higher than A11 (except where BA is required) and data bits higher than DQ7 are don't cares.
- 1. The reset command returns device to reading array.
- 2. Cycle 4 programs the addressed locking bit. Cycles 5 and 6 validate bit has been fully programmed when DQ0 = 1. If DQ0 = 0 in cycle 6, program command must be issued and verified again.
- 3. Data is latched on the rising edge of WE#.
- 4. Entire command sequence must be entered for each portion of password.
- 5. Command sequence returns FFh if PPMLB is set.
- 6. The password is written over four consecutive cycles, at addresses 0-3.
- 7. A 2us timeout is required between any two portions of password.
- 8. A 120us timeout is required between cycles 4 and 5.
- 9. A 3ms timeout is required between cycles 4 and 5.
- 10. Cycle 4 erases all PPBs. Cycles 5 and 6 validate bits have been fully erased when DQ0 = 0. If DQ0 = 1 in cycle 6, erase command must be issued and verified again. Before issuing erase command, all PPBs should be programmed to prevent PPB overerasure.
- 11. DQ1 = 1 if PPB locked, 0 if unlocked.
- 12. A22 has to be fixed whenever command is issued to the device in order to select one chip of the whole chip. For example, when A22 is Low, 1st chip is selected. And when A22 is High, : 2nd chip is selected.



Table 11. Common Flash Memory Interface Code

10H 0051H 0051H 10H 0051H 10H 0052H 12H 0059H 13H 0002H 14H 0000H 14H 0000H 14H 0000H 14H 0000H 16H 0000H 16H	Description	Addresses (Word Mode)	Data
Primary OEM Command Set		-	
Primary OEM Command Set 13H 0002H 14H 0000H Address for Primary Extended Table 15H 0040H 16H 0000H Alternate OEM Command Set (00h = none exists) 17H 0000H Address for Alternate OEM Extended Table (00h = none exists) 18H 0000H Address for Alternate OEM Extended Table (00h = none exists) 19H 0000H Vcc Min. (write/erase) D7-D4: volt, D3-D0: 100 millivolt Vcc Max. (write/erase) D7-D4: volt, D3-D0: 100 millivolt Vpp Min. voltage(00H = no Vpp pin present) 1DH 0000H Vpp Min. voltage(00H = no Vpp pin present) 1DH 0000H Typical timeout per single word write 2 th us 1FH 0003H Typical timeout for fill chip erase 2 th ms (00H = not supported) 2DH 0000H Max. timeout for full chip erase 2 th times typical 23H 0004H Max. timeout for vold write 2 th times typical 23H 0004H Max. timeout for full chip erase 2 th times typical 25H 0000H Max. timeout for full chip erase 2 th times typical 25H 0000H Max. timeout for full chip erase 2 th times typical 25H 0000H Max. timeout for full chip erase 2 th times typical 25H 0000H Max. timeout for buffer write 2 th times typical 25H 0000H Max. timeout for buffer write 2 th times typical 25H 0000H Max. timeout for buffer write 2 th times typical 26H 0000H Max. timeout for buffer write 2 th times typical 27H 0017H Flash Device Interface description 28H 0000H Max. number of byte in multi-byte write = 2 th 28H 0000H Number of Erase Block Regions within device 2CH 0003H Erase Block Region 1 Information 27H 0000H Erase Block Region 2 Information 33H 0000H 34H 0000H	Query Unique ASCII string "QRY"		
Primary OEM Command Set			
Address for Primary Extended lable Alternate OEM Command Set (00h = none exists) Alternate OEM Command Set (00h = none exists) Address for Alternate OEM Extended Table (00h = none exists) Address for Alternate OEM Extended Table (00h = none exists) Pyp Min. (write/erase) Dy -D-04: volt, D3-D0: 100 millivolt Voz Max. (write/erase) Dy -D-04: volt, D3-D0: 100 millivolt Vpp Min. voltage(00H = no Vpp pin present) App Min. voltage(00H = no Vpp pin present) Typical timeout per single word write 2 ^N us 1FH 0000H Typical timeout for Min. size buffer write 2 ^N us(00H = not supported) Typical timeout for Min. size buffer write 2 ^N us(00H = not supported) Amx. timeout for lull chip erase 2 ^N misc (00H = not supported) Amx. timeout for word write 2 ^N times typical Amx. timeout for buffer write 2 ^N times typical Amx. timeout for full chip erase 2 ^N times typical Amx. timeout for full chip erase 2 ^N times typical Amx. timeout for full chip erase 2 ^N times typical Amx. timeout for full chip erase 2 ^N times typical Amx. timeout for full chip erase 2 ^N times typical Amx. timeout for full chip erase 2 ^N times typical Amx. timeout for full chip erase 2 ^N times typical Amx. timeout for full chip erase 2 ^N times typical Amx. timeout for full chip erase 2 ^N times typical Amx. timeout for full chip erase 2 ^N times typical Amx. number of byte in multi-byte write = 2 ^N 2AH 0000H Amx. number of Erase Block Regions within device 2CH 0003H Erase Block Region 1 Information 2FH 0000H Erase Block Region 2 Information 31H 0000H Erase Block Region 2 Information	Primary OEM Command Set		
Alternate OEM Command Set (00h = none exists) Alternate OEM Command Set (00h = none exists) 177H 0000H 18H 0000H 19P-Livoit, D3-D0: 100 millivoit 10H 0036H 17P-D4: voit, D3-D0: 100 millivoit 10H 0000H 19P Max. voitage(00H = no Vpp pin present) 11DH 0000H 19P Max. voitage(00H = no Vpp pin present) 11DH 0000H 17P 0000H 17P 19P 19P 19P 19P 19P 19P 19P 19P 19P 19	Address for Drivery, Futer ded Table	15H	0040H
Alternate OEM Command Set (UOn = none exists) Address for Alternate OEM Extended Table (00h = none exists) Address for Alternate OEM Extended Table (00h = none exists) 19H 00000H Vcc Min. (write/erase) D7-D4: volt, D3-D0: 100 millivolt 10H 0036H Vpp Min. voltage(00H = no Vpp pin present) 11DH 0000H Vpp Min. voltage(00H = no Vpp pin present) 11DH 0000H Typical timeout per single word write 2* us (00H = not supported) 12DH 0000H Typical timeout for Min. size buffer write 2* us(00H = not supported) 12DH 0000H Typical timeout for full chip erase 2* ms(00H = not supported) 22DH 0000H Max. timeout for word write 2* times typical 23DH 0000H Max. timeout for buffer write 2* times typical 24DH 0000H Max. timeout for full chip erase 2* times typical 25DH 0000H Max. timeout for full chip erase 2* times typical 26DH 0000H Max. timeout for full chip erase 2* times typical 27DH 0000H Max. timeout for full chip erase 2* times typical 28DH 0000H Max. timeout for full chip erase 2* times typical 28DH 0000H Max. number of byte in multi-byte write = 2* 28DH 0000H Call Call Call Call Call Call Call Cal	Address for Primary Extended Table	16H	0000H
Address for Alternate OEM Extended Table (00h = none exists) 19H 0000H Voc Min. (write/erase) D7-D4: volt, D3-D0: 100 millivolt 1BH 0027H Voc Max. (write/erase) D7-D4: volt, D3-D0: 100 millivolt Vpp Min. voltage(00H = no Vpp pin present) 1DH 0000H Vpp Min. voltage(00H = no Vpp pin present) 1DH 0000H Typical timeout per single word write 2 ^N us 1FH 0003H Typical timeout for Min. size buffer write 2 ^N us(00H = not supported) 1Typical timeout for full chip erase 2 ^N ms(00H = not supported) 2DH 0000H Max. timeout for full chip erase 2 ^N times typical 23H 0004H Max. timeout for buffer write 2 ^N times typical 24H 0000H Max. timeout for full chip erase 2 ^N times typical 25H 0004H Max. timeout for full chip erase 2 ^N times typical 26H 0000H Max. timeout for full chip erase 2 ^N times typical 27H 0017H Flash Device Interface description 28H 0000H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Max. number of Erase Block Regions within device 2CH 0003H Erase Block Region 1 Information 21H 0000H Erase Block Region 2 Information 32H 0000H Erase Block Region 2 Information	Alternate OEM Command Set (00h = none exists)		
Address for Alternate DEM Extended Table (UUn = none exists) 1AH 0000H	, ,		
D7-D4: volt, D3-D0: 100 millivolt 1BH 0027H Vcc Max. (write/erase) 1CH 0036H D7-D4: volt, D3-D0: 100 millivolt 1CH 0036H Vpp Min. voltage(00H = no Vpp pin present) 1DH 0000H Vpp Max. voltage(00H = no Vpp pin present) 1EH 0000H Typical timeout per single word write 2 ^N us 1FH 0003H Typical timeout for Min. size buffer write 2 ^N us(00H = not supported) 20H 0000H Typical timeout per individual block erase 2 ^N ms 21H 0009H Typical timeout for full chip erase 2 ^N ms(00H = not supported) 22H 0000H Max. timeout for full chip erase 2 ^N times typical 23H 0004H Max. timeout for buffer write 2 ^N times typical 24H 0000H Max. timeout for full chip erase 2 ^N times typical 25H 0004H Max. timeout for full chip erase 2 ^N times typical 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 28H 0000H Max. number of Erase	Address for Alternate OEM Extended Table (00h = none exists)		
D7-D4: Volt, D3-D0: 100 millivolt 1CH 0036H Vcc Max. (write/erase) 1DH 0000H Vpp Min. voltage(00H = no Vpp pin present) 1DH 0000H Vpp Min. voltage(00H = no Vpp pin present) 1EH 0000H Typical timeout per single word write 2 ^N us 1FH 0003H Typical timeout for Min. size buffer write 2 ^N us(00H = not supported) 20H 0000H Typical timeout for full chip erase 2 ^N ms(00H = not supported) 21H 0009H Typical timeout for full chip erase 2 ^N ms(00H = not supported) 22H 0000H Max. timeout for write 2 ^N times typical 23H 0004H Max. timeout for buffer write 2 ^N times typical 25H 0000H Max. timeout for full chip erase 2 ^N times typical 25H 0000H Max. timeout for full chip erase 2 ^N times typical(00H = not supported) 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 28H 0000H Number of Erase Block Regions within device 2CH 0000H <t< td=""><td>Vcc Min. (write/erase)</td><td>4511</td><td>000711</td></t<>	Vcc Min. (write/erase)	4511	000711
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D7-D4: Volt, D3-D0: 100 millivolt Vpp Min. voltage(00H = no Vpp pin present) 1DH 0000H Vpp Max. voltage(00H = no Vpp pin present) 1EH 0000H Typical timeout per single word write 2 ^N us (00H = not supported) 20H 0000H Typical timeout for Min. size buffer write 2 ^N us(00H = not supported) 20H 0000H Typical timeout per individual block erase 2 ^N ms(00H = not supported) 22H 0000H Max. timeout for full chip erase 2 ^N ms(00H = not supported) 22H 0000H Max. timeout for word write 2 ^N times typical 23H 0004H Max. timeout for buffer write 2 ^N times typical 24H 0000H Max. timeout for full chip erase 2 ^N times typical 25H 0004H Max. timeout for full chip erase 2 ^N times typical(00H = not supported) 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Number of Erase Block Regions within device 2CH 0003H Erase Block Region 1 Information 32H 0000H	,	1CH	0036H
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Typical timeout per single word write 2 ^N us 1FH 0003H Typical timeout for Min. size buffer write 2 ^N us(00H = not supported) 20H 0000H Typical timeout per individual block erase 2 ^N ms 21H 0009H Typical timeout for full chip erase 2 ^N ms(00H = not supported) 22H 0000H Max. timeout for word write 2 ^N times typical 23H 0004H Max. timeout for buffer write 2 ^N times typical 24H 0000H Max. timeout for full chip erase 2 ^N times typical (00H = not supported) 26H 0000H Max. timeout for full chip erase 2 ^N times typical(00H = not supported) 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Number of Erase Block Regions within device 2CH 003H Erase Block Region 1 Information 2EH 0000H Erase Block Region 2 Information 31H 007DH Erase Block Region 2 Information 35H 0007H 35H 0000H		1DH	0000H
Typical timeout for Min. size buffer write 2 ^N us(00H = not supported) 20H 0000H Typical timeout per individual block erase 2 ^N ms 21H 0009H Typical timeout for full chip erase 2 ^N ms(00H = not supported) 22H 0000H Max. timeout for word write 2 ^N times typical 23H 0004H Max. timeout for buffer write 2 ^N times typical 24H 0000H Max. timeout per individual block erase 2 ^N times typical 25H 0004H Max. timeout for full chip erase 2 ^N times typical(00H = not supported) 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Number of Erase Block Regions within device 2CH 0003H Erase Block Region 1 Information 2DH 0007H Erase Block Region 2 Information 31H 007DH Erase Block Region 2 Information 33H 0000H 36H 0000H 0000H 36H 0000H	Vpp Max. voltage(00H = no Vpp pin present)	1EH	0000H
Typical timeout per individual block erase 2 ^N ms 21H 0009H Typical timeout for full chip erase 2 ^N ms(00H = not supported) 22H 0000H Max. timeout for word write 2 ^N times typical 23H 0004H Max. timeout for buffer write 2 ^N times typical 24H 0000H Max. timeout per individual block erase 2 ^N times typical 25H 0004H Max. timeout for full chip erase 2 ^N times typical(00H = not supported) 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Number of Erase Block Regions within device 2CH 003H Erase Block Region 1 Information 2EH 0000H Erase Block Region 2 Information 33H 0000H 33H 0000H 33H 0000H 36H 0000H	Typical timeout per single word write 2 ^N us	1FH	0003H
Typical timeout for full chip erase 2 ^N ms(00H = not supported) 22H 0000H Max. timeout for word write 2 ^N times typical 23H 0004H Max. timeout for buffer write 2 ^N times typical 24H 0000H Max. timeout per individual block erase 2 ^N times typical 25H 0004H Max. timeout for full chip erase 2 ^N times typical(00H = not supported) 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Number of Erase Block Regions within device 2CH 003H Erase Block Region 1 Information 2FH 0020H Erase Block Region 2 Information 31H 007DH Erase Block Region 2 Information 35H 0000H 36H 0007H 0007H 36H 0007H 0007H	Typical timeout for Min. size buffer write 2^N us(00H = not supported)	20H	0000H
Max. timeout for word write 2 ^N times typical 23H 0004H Max. timeout for buffer write 2 ^N times typical 24H 0000H Max. timeout per individual block erase 2 ^N times typical 25H 0004H Max. timeout for full chip erase 2 ^N times typical(00H = not supported) 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Number of Erase Block Regions within device 2CH 0003H Erase Block Region 1 Information 2DH 0000H Erase Block Region 2 Information 31H 007DH Erase Block Region 2 Information 33H 0000H 33H 0000H 36H 000H	Typical timeout per individual block erase 2 ^N ms	21H	0009H
Max. timeout for buffer write 2 ^N times typical 24H 0000H Max. timeout per individual block erase 2 ^N times typical 25H 0004H Max. timeout for full chip erase 2 ^N times typical(00H = not supported) 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Number of Erase Block Regions within device 2CH 0003H Erase Block Region 1 Information 2DH 0007H Erase Block Region 2 Information 31H 007DH Erase Block Region 2 Information 33H 0000H 33H 0000H 34H 0001H 35H 0007H 36H 0000H	Typical timeout for full chip erase 2 ^N ms(00H = not supported)	22H	0000H
Max. timeout per individual block erase 2 ^N times typical 25H 0004H Max. timeout for full chip erase 2 ^N times typical(00H = not supported) 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Number of Erase Block Regions within device 2CH 0003H Erase Block Region 1 Information 2EH 0000H Erase Block Region 2 Information 31H 007DH Erase Block Region 2 Information 35H 0007H 35H 0007H 36H 0000H	Max. timeout for word write 2 ^N times typical	23H	0004H
Max. timeout for full chip erase 2 ^N times typical(00H = not supported) 26H 0000H Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Number of Erase Block Regions within device 2CH 003H Erase Block Region 1 Information 2DH 0007H Erase Block Region 2 Information 31H 007DH Erase Block Region 2 Information 33H 0000H 33H 0000H 34H 0001H 36H 0007H 000H 36H 0007H 000H 36H 0007H	Max. timeout for buffer write 2 ^N times typical	24H	0000H
Device Size = 2 ^N byte 27H 0017H Flash Device Interface description 28H 0001H Max. number of byte in multi-byte write = 2 ^N 2AH 0000H Number of Erase Block Regions within device 2CH 0003H Erase Block Region 1 Information 2EH 0000H Erase Block Region 2 Information 31H 007DH Erase Block Region 2 Information 33H 0000H 33H 0000H 34H 0001H 35H 0007H 36H 0000H	Max. timeout per individual block erase 2 ^N times typical	25H	0004H
Flash Device Interface description 28H 29H 0000H	Max. timeout for full chip erase 2 ^N times typical(00H = not supported)	26H	0000H
Plash Device Interface description 29H 0000H	Device Size = 2 ^N byte	27H	0017H
Max. number of byte in multi-byte write = 2N 2AH	Flach Davico Interface description	28H	0001H
Max. number of byte in multi-byte write = 2 nd 2BH 0000H	Hash Device interface description	29H	0000H
Number of Erase Block Regions within device 2CH 0003H Erase Block Region 1 Information 2DH 2EH 0000H 2FH 0020H 30H 0000H 0000H 31H 007DH 32H 0000H 33H 0000H 34H 007DH 0000H 36H	Max. number of byte in multi-byte write = 2 ^N		
Erase Block Region 1 Information Erase Block Region 2 Information Erase Block Region 2 Information 2DH 0007H 2EH 0000H 30H 0000H 31H 007DH 32H 0000H 33H 0000H 34H 0001H	Number of Erose Plack Pagions within device		
Erase Block Region 1 Information 2EH 0000H 2FH 0020H 30H 0000H 30H 0000H Erase Block Region 2 Information 31H 007DH 32H 0000H 33H 0000H 34H 0001H 34H 0001H 36H 0000H 36H 0000H 36H 0000H 36H 0000H	Number of clase block regions within device		
Erase Block Region 1 Information 2FH 0020H 30H 0000H Erase Block Region 2 Information 31H 007DH 32H 0000H 33H 0000H 34H 0001H 35H 0007H 36H 0000H			
Erase Block Region 2 Information 31H 007DH 32H 0000H 33H 0000H 34H 0001H 35H 0007H	Erase Block Region 1 Information		0020H
Erase Block Region 2 Information 32H 0000H 33H 0000H 34H 0001H 35H 0007H 36H 0000H			
Erase Block Region 2 Information 33H 0000H 34H 0001H 35H 0007H 36H 0000H			
34H 0001H 35H 0007H 36H 0000H	Erase Block Region 2 Information		
36H 0000H			
36H 0000H			
Frace Block Pegion 3 Information	Erase Block Region 3 Information		
37H 0020H 38H 0000H			
39H 0000H			
Frase Block Region 4 Information 3AH 0000H	Frase Block Region 4 Information	3AH	0000H
3BH 0000H 3CH 0000H	Liado Dioux Negion 4 information		



Table 11. Common Flash Memory Interface Code

Description	Addresses (Word Mode)	Data
Query-unique ASCII string "PRI"	40H 41H 42H	0050H 0052H 0049H
Major version number, ASCII	43H	0030H
Minor version number, ASCII	44H	0030H
Address Sensitive Unlock(Bits 1-0) 0 = Required, 1= Not Required Silcon Revision Number(Bits 7-2)	45H	0000Н
Erase Suspend 0 = Not Supported, 1 = To Read Only, 2 = To Read & Write	46H	0002H
Block Protect 00 = Not Supported, 01 = Supported	47H	0001H
Block Temporary Unprotect 00 = Not Supported, 01 = Supported	48H	0001H
Block Protect/Unprotect scheme, 00 = Not Supported, 01 = Supported	49H	0001H
Simultaneous Operation 00 = Not Supported, 01 = Supported	4AH	0001H
Burst Mode Type 00 = Not Supported, 01 = Supported	4BH	0000H
Page Mode Type 00 = Not Supported, 01 = 4 Word Page 02 = 8 Word Page	4CH	0002H
ACC(Acceleration) Supply Minimum 00 = Not Supported, D7 - D4 : Volt, D3 - D0 : 100mV	4DH	0085H
ACC(Acceleration) Supply Maximum 00 = Not Supported, D7 - D4 : Volt, D3 - D0 : 100mV	4EH	0095H
Top/Bottom Boot Block Flag 02H = Bottom Boot Device, 03H = Top Boot Device, 04H = Top and Bottom Device	4FH	0004H

Note: The K8Q2815UQB has C.F.I information that is same with 64Mb (K8P6415UQB)

DEVICE STATUS FLAGS

The K8Q2815UQB has means to indicate its status of operation in the bank where a program or erase operation is in processes. Address must include bank address being excuted internal routine operation. The status is indicated by raising the device status flag via corresponding DQ pins or the RY/ BY pin. The corresponding DQ pins are DQ7, DQ6, DQ5, DQ3 and DQ2. The statuses are as follows: A22 has to be fixed whenever command is issued to the device in order to select one chip of the whole chip. For example, when A22 is Low, 1st chip is selected. And when A22 is High,: 2nd chip is selected.

Table 12. Hardware Sequence Flags

	Statu	DQ7	DQ6	DQ5	DQ3	DQ2	RY/BY	
	Programming			Toggle	0	0	1	0
	Block Erase or Chip Erase	9	0	Toggle	0	1	Toggle	0
In Progress Erase Suspend Read Program Program Suspend Read	Erase Suspend Read	Erase Suspended Block	1	1	0	0	Toggle (Note 1)	1
	Erase Suspend Read	Non-Erase Sus- pended Block	Data	Data	Data	Data	Data	1
	· · · · · · · · · · · · · · · · · · ·		DQ7	Toggle	0	0	1	0
	Program Suspend Read Program Suspended Block		DQ7	1	0	0	Toggle (Note 1)	1
	Program Suspend Read Non-Program Suspended Block		Data	Data	Data	Data	Data	1
	Programming		DQ7	Toggle	1	0	No Toggle	0
Exceeded Time Limits	Block Erase or Chip Erase		0	Toggle	1	1	(Note 2)	0
Time Limits	Erase Suspend Program	DQ7	Toggle	1	0	No Toggle	0	

Notes

- 1. DQ2 will toggle when the device performs successive read operations from the erase/program suspended block.
- 2. If DQ5 is High (exceeded timing limits), successive reads from a problem block will cause DQ2 to toggle.

DQ7: Data Polling

When an attempt to read the device is made while executing the Internal Program, the complement of the data is written to DQ7 as an indication of the Routine in progress. When the Routine is completed an attempt to access to the device will produce the true data written to DQ7. When a user attempts to read the block being erased, DQ7 will be low. If the device is placed in the Erase/Program Suspend Mode, the status can be detected via the DQ7 pin. If the system tries to read an address which belongs to a block that is being erase suspended, DQ7 will be high. And, if the system tries to read an address which belongs to a block that is being program suspended, the output will be the true data of DQ7 itself. If a non-erase-suspended or non-program-suspended block address is read, the device will produce the true data to DQ7. If an attempt is made to program a protected block, DQ7 outputs complements the data for approximately $1\mu s$ and the device then returns to the Read Mode without changing data in the block. If an attempt is made to erase a protected block, DQ7 outputs complement data in approximately 100us and the device then returns to the Read Mode without erasing the data in the block.

DQ6: Toggle Bit

Toggle bit is another option to detect whether an Internal Routine is in progress or completed. Once the device is at a busy state, DQ6 will toggle. Toggling DQ6 will stop after the device completes its Internal Routine. If the device is in the Erase/Program Suspend Mode, an attempt to read an address that belongs to a block that is being erased or programmed will produce a high output of DQ6. If an address belongs to a block that is not being erased or programmed, toggling is halted and valid data is produced at DQ6. If an attempt is made to program a protected block, DQ6 toggles for approximately 1us and the device then returns to the Read Mode without changing the data in the block. If an attempt is made to erase a protected block, DQ6 toggles for approximately 100µs and the device then returns to the Read Mode without erasing the data in the block. #OE or #CE should be toggled in each toggle bit status read.



DQ5: Exceed Timing Limits

If the Internal Program/Erase Routine extends beyond the timing limits, DQ5 will go High, indicating program/erase failure.

DQ3: Block Erase Timer

The status of the multi-block erase operation can be detected via the DQ3 pin. DQ3 will go High if $50\mu s$ of the block erase time window expires. In this case, the Internal Erase Routine will initiate the erase operation. Therefore, the device will not accept further write commands until the erase operation is completed. DQ3 is Low if the block erase time window is not expired. Within the block erase time window, an additional block erase command (30H) can be accepted. To confirm that the block erase command has been accepted, the software may check the status of DQ3 following each block erase command.

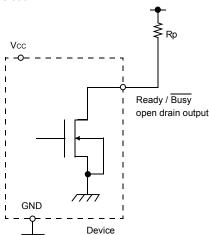
DQ2: Toggle Bit 2

The device generates a toggling pulse in DQ2 only if an Internal Erase Routine or an Erase/Program Suspend is in progress. When the device executes the Internal Erase Routine, DQ2 toggles only if an erasing bank is read. Although the Internal Erase Routine is in the Exceeded Time Limits, DQ2 toggles only if an erasing block in the Exceeded Time Limits is read. When the device is in the Erase/Program Suspend mode, DQ2 toggles only if an address in the erasing or programming block is read. If a non-erasing or non-programmed block address is read during the Erase/Program Suspend mode, then DQ2 will produce valid data. DQ2 will go High if the user tries to program a non-erase suspend block while the device is in the Erase Suspend mode. #OE or #CE should be toggled in each toggle bit status read.

RY/BY : Ready/Busy

The K8Q2815UQB has a Ready / $\overline{\text{Busy}}$ output that indicates either the completion of an operation or the status of Internal Algorithms. If the output is Low, the device is busy with either a program or an erase operation. If the output is High, the device is ready to accept any read/write or erase operation. When the RY/ $\overline{\text{BY}}$ pin is low, the device will not accept any additional program or erase commands with the exception of the Erase Suspend command. If the K8Q2815UQB is placed in an Erase Suspend mode, the RY/ $\overline{\text{BY}}$ output will be High. For programming, the RY/ $\overline{\text{BY}}$ is valid (RY/ $\overline{\text{BY}}$ = 0) after the rising edge of the fourth $\overline{\text{WE}}$ pulse in the four write pulse sequence. For Chip Erase, RY/ $\overline{\text{BY}}$ is also valid after the rising edge of $\overline{\text{WE}}$ pulse in the six write pulse sequence. For Block Erase, RY/ $\overline{\text{BY}}$ is also valid after the rising edge of the sixth $\overline{\text{WE}}$ pulse.

The pin is an open drain output, allowing two or more Ready/ Busy outputs to be OR-tied. An appropriate pull-up resistor is required for proper operation.



$$Rp = \frac{Vcc (Max.) - Vol (Max.)}{Iol + \sum IL} = \frac{3.2 \text{ V}}{2.1\text{mA} + \sum IL}$$

where Σ IL is the sum of the input currents of all devices tied to the Ready / $\overline{\text{Busy}}$ pin.

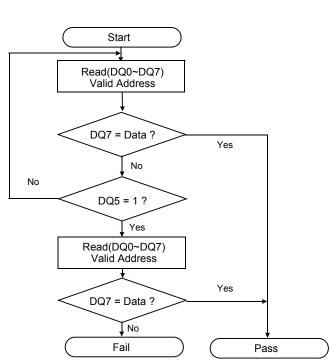


Figure 9. Data Polling Algorithms

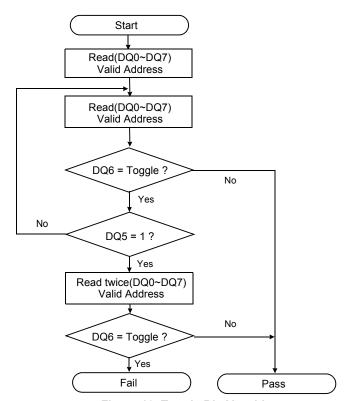


Figure 10. Toggle Bit Algorithms

ABSOLUTE MAXIMUM RATINGS

Parameter		Symbol	Rating	Unit
	Vcc	Vcc	-0.5 to +4.0	
Voltage on any pin relative to Vss	A9, $\overline{\text{OE}}$, $\overline{\text{RESET}}$	-0.5 to +9.5		V
voltage off any pin relative to vss	WP/ACC	Vin	-0.5 to +9.5	V
	All Other Pins		-0.5 to +(Vcc+0.5)	
Temperature Under Bias	Commercial	Thias	-10 to +125	°C
Temperature Orider bias	Extended	I bias	-25 to +125	C
Storage Temperature	Storage Temperature		-65 to +150	°C
Short Circuit Output Current		los	5	mA
Operating Temperature		Ta (Industrial Temp.)	-40 to +85	°C
		Ta (Extended Temp.)	-25 to + 85	°C
		TA (Commercial Temp.)	0 to + 70	°C

Notes:

- 1. Minimum DC voltage is -0.5V on Input/ Output pins. During transitions, this level may fall to -2.0V for periods <20ns. Maximum DC voltage on
- input / output pins is Vcc+0.5V which, during transitions, may overshoot to Vcc+2.0V for periods <20ns. Maximum DC voltage is -0.5V on A9, OE, RESET and WP/ACC pins. During transitions, this level may fall to -2.0V for periods <20ns. Maximum DC voltage is -0.5V on A9, OE, RESET and WP/ACC pins. During transitions, this level may fall to -2.0V for periods <20ns. Maximum DC voltage on A9, OE, RESET, WP/ACC pins is 9.5V which, during transitions, may overshoot to 14.0V for periods <20ns.

 3. Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to the conditions
- detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

RECOMMENDED OPERATING CONDITIONS (Voltage reference to GND)

Parameter	Symbol	Min	Тур.	Max	Unit
Supply Voltage	Vcc	2.7	3.0	3.6	V
Supply Voltage	Vss	0	0	0	V

DC CHARACTERISTICS

Parameter	Sym bol	Test Conditions		Min	Тур	Max	Un it
Input Leakage Current	lu	VIN=VSS to VCC, VCC=VC	CCmax	- 1.0	-	+ 1.0	μА
A9, OE, RESET Input Leakage Current	Iыт	VCC=VCCmax, A9, OE, RES	SET=9.5V	-	-	35	μА
WP/ACC Input Leakage Current	ILIW	VCC=VCCmax, WP/ACC=9	9.5V	-	-	35	μА
Output Leakage Current	llo	VOUT=VSS to VCC,VCC=V	/CC-	- 1.0	-	+ 1.0	μА
Active Read Current (1)	Icc1	OE=VIH. VCC=VCCmax	10MHz	-	45	55	mA
Active Read Current (1)	ICCT	OE-VIH, VCC-VCCIIIAX	5MHz	-	20	30	IIIA
Active Write Current (2)	Icc2	CE=VIL, OE=VIH, WE=VIL	CE=VIL, OE=VIH, WE=VIL		15	30	mA
Read While Program Current (3)	Icc3	CE=VIL, OE=VIH (@10Mhz)		-	35	55	mA
Read While Erase Current (3)	Icc4	CE=VIL, OE=VIH (@10Mhz)		-	35	55	mA
Program While Erase Suspend Current	Icc5	CE=VIL, OE=VIH	CE=VIL, OE=VIH		15	35	mA
Page Read Current	Icc6	OE=VIH, 8 word Page Read		-	10	22	mA
ACC Accelerated Program Current	IACC	CE=VIL, OE=VIH		-	15	30	mA
Standby Current	Is _B 1	CE, RESET, WP/ACC= Vcc	± 0.3	-	30	60	μА
Standby Current During Reset	IsB2	RESET= Vss± 0.3		-	30	60	μА
Automatic Sleep Mode	Isa3	VIH=Vccq \pm 0.3V, VIL=Vss \pm 0.2V		-	30	60	μА
Input Low Level	VIL	Vccq=1.65~1.95V(2.7~3.6V)		-0.4(-0.5)	-	0.4(0.8)	V
Input High Level	VIH	Vccq=1.65~1.95V(2.7~3.6V)		Vccq-0.4(2.2)	-	Vccq+0.4 (Vcc+0.3)	٧
Voltage for WP/ACC Block Temporarily Unprotect and Program Acceleration (4)	Vнн	Vcc = 3.0V ± 0.15V		8.5	-	9.5	V



Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Voltage for Autoselect and Block Protect (4)	VID	Vcc = 3.0V ± 10%	8.5	-	9.5	V
Output Low Level	Vol	IOL =100uA,Vcc=VCCmin, Vccq=1.65~1.95V	-		0.1	V
	VOL	IOL =2.0mA,Vcc=VCCmin, Vccq=2.7~3.6V	-		0.4	V
Output High Lovel	Vон	IOH = -100uA, Vcc=VCCmin, Vccq=1.65~1.95V	Vccq-0.1	-	-	V
Output High Level		IOH = -2.0mA, Vcc=VCCmin, Vccq=2.7~3.6V	2.4	-	-	V
Low VCC Lock-out Voltage (5)	VLKO		2.3	1	2.5	V

Notes :

- 1. The lcc current listed includes both the DC operating current and the frequency dependent component(at 10 MHz).
- 2. Icc active during Internal Routine(program or erase) is in progress.
- 3. Icc active during Read while Write is in progress.
- 4. The high voltage (VHH or VID) must be used in the range of Vcc = 3.0V \pm 0.15V
- 5. Not 100% tested.
- 6. Typical value are measured at Vcc = 3.0V,TA=25°C , Not 100% tested.

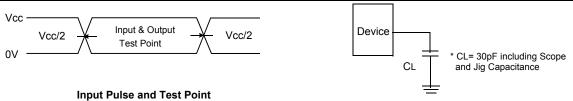
CAPACITANCE(TA = 25 °C, Vcc = 3.0V, f = 1.0MHz)

Item	Symbol	Test Condition	Min	Max	Unit
Input Capacitance	Cin	VIN=0V	-	20	pF
Output Capacitance	Соит	Vout=0V	-	20	pF
Control Pin Capacitance	CIN2	VIN=0V	-	20	pF

Note: Capacitance is periodically sampled and not 100% tested.

AC TEST CONDITION

Parameter	Value
Input Pulse Levels	0V to Vcc
Input Rise and Fall Times(Vccq=1.8,3.0V)	5ns
Input and Output Timing Levels	Vcc/2
Output Load	CL = 30pF



AC CHARACTERISTICS Read Operations

Output Load

	Symbol	Vcc=2.7V~3.6V						
Parameter		4B		4C		4D		Unit
		Min	Max	Min	Max	Min	Max	
Read Cycle Time (1)	trc	60	-	65	-	70	-	ns
Address Access Time	taa	-	60	-	65	-	70	ns
Chip Enable Access Time	tce	-	60	-	65	-	70	ns
Output Enable Time	toe	-	25	-	30	-	30	ns
Page Read Cycle Time (1)	tprc	25	-	25	-	30	-	ns
Page Address Access Time	t PA	-	25	-	25	-	30	ns
CE & OE Disable Time (1)	tDF	-	16	-	16	-	16	ns
Output Hold Time from Address, CE or OE (1)	tон	5	-	5	-	5	-	ns

Note: 1. Not 100% tested.



AC CHARACTERISTICS Write(Erase/Program)Operations

Alternate WE Controlled Write

Parameter			Vcc=2.7V ~ 3.6V						
		Symbol	4B		4C		4D		Unit
			Min	Max	Min	Max	Min	Max	
Write Cycle	e Time (1)	twc	60	-	65	-	70	-	ns
Address Co	A.I. 0.4 T		0	-	0	-	0	-	ns
Address Setup Time		taso	15	-	15	-	15	-	ns
Addross He	Address Held Time		35	-	35	-	35	-	ns
Address Hold Time		taht	0	-	0	-	0	-	ns
Data Setup	Time	tos	30	-	30	-	30	-	ns
Data Hold	Time	tон	0	-	0	-	0	-	ns
Output Ena	able Setup Time (1)	toes	0	-	0	-	0	-	ns
Output	Read (1)	toeh1	0	-	0	-	0	-	ns
Enable Hold	Toggle and Data Polling (1)	toeh2	10	-	10	-	10	-	ns
CE Setup 1	Time	tcs	0	-	0	-	0	-	ns
CE Hold Ti	me	tсн	0	-	0	-	0	-	ns
Write Pulse	Write Pulse Width		35	-	35	-	35	-	ns
Write Pulse	Write Pulse Width High		25	-	25	-	25	-	ns
Programming Operation		tрдм	6(typ)		6(typ.)		6(typ.)		μS
Accelerated Programming Operation		taccpgm	6(typ)		6(typ.)		6(typ.)		μS
Accelerated Quad word Programming Operation		taccpgm_qu ad	1.5(typ.)		1.5(typ.)		1.5(typ.)		μS
Block Erase	e Operation (2)	tBERS	0.7(typ)		0.7(typ.)		0.7(typ.)		sec
Vcc Set Up	o Time	tvcs	50	-	50	-	50	-	μS
Write Reco	overy Time from RY/BY	tпв	0	-	0	-	0	-	ns
RESET High Time Before Read		tкн	50	-	50	-	50	-	ns
RESET to I	Power Down Time	trpd	20	-	20	-	20	-	μS
Program/E	rase Valid to RY/BY Delay	tBUSY	35	90	35	90	35	90	ns
VID Rising	Vid Rising and Falling Time		500	-	500	-	500	-	ns
RESET Pu	RESET Pulse Width		500	-	500	-	500	-	ns
RESET Low to RY/BY High		trrb	-	20	-	20	-	20	μS
RESET Setup Time for Temporary Unprotect		trsp	4	-	4	-	4	-	μS
RESET Low Setup Time		trsts	500	-	500	-	500	-	ns
RESET High to Address Valid		trstw	200	-	200	-	200	-	ns
Read Recovery Time Before Write		tghwl	0	-	0	-	0	-	ns
CE High du	CE High during toggling bit polling		20	-	20	-	20	-	ns
OE High du	OE High during toggling bit polling		10	-	10	-	10	-	ns



Notes: 1. Not 100% tested.
2. The duration of the Program or Erase operation varies and is calculated in the internal algorithms.

AC CHARACTERISTICS Write(Erase/Program)Operations Alternate CE Controlled Writes

					Vcc=2.7	'V ~ 3.6V			
	Parameter	Symbol	4	4B	4	C	4	4D	Unit
			Min	Max	Min	Max	Min	Max	
Write Cy	cle Time (1)	twc	60	-	65	-	70	-	ns
Address	Setup Time	tas	0	-	0	-	0	-	ns
Address	Hold Time	tah	35	-	35	-	35	-	ns
Data Set	tup Time	tos	30	-	30	-	30	-	ns
Data Hol	ld Time	tDH	0	-	0	-	0	-	ns
Output E	Enable Setup Time (1)	toes	0	-	0	-	0	-	ns
Output	Read (1)	toeh1	0	-	0	-	0	-	ns
Enable Hold Time	Toggle and Data Polling (1)	tOEH2	10	-	10	-	10	-	ns
WE Setu	ıp Time	tws	0	-	0	-	0	-	ns
WE Hold	I Time	twн	0	-	0	-	0	-	ns
CE Pulse	e Width	tcp	40	-	40	-	40	-	ns
CE Pulse	e Width High	tсрн	25	-	25	-	25	-	ns
Program	ming Operation	tpgm	6(typ)		6(typ.)		6(typ.)		μS
Accelera ation	ted Programming Oper-	taccpgm	6(typ)		6typ.)		6(typ.)		μS
	ited Quad word Pro- ig Operation	taccpgm_quad	1.5(typ.)		1.5(typ.)		1.5(typ.)		μS
Block Era	ase Operation (2)	tBERS	0.7	(typ)	0.7	typ.)	0.7(typ.)		sec

Notes: 1. Not 100% tested.

2. This does not include the preprogramming time.

ERASE AND PROGRAM PERFORMANCE

Parameter		Limits		Unit	C Includes 00H programming prior to erasure Excludes system-level overhead Minimum 100 000 cycles quaran-
Parameter	Min	Тур	Max	Unit	Comments
Block Erase Time	-	0.7	2	sec	Includes 00H programming
Chip Erase Time (Each chip)	-	71	113.6	sec	prior to erasure
Word Programming Time	-	6	100	μS	Excludes system-level overhead
Accelerated Word Program Time	-	6	100	μS	Excludes system-level overhead
Accelerated Quad Word Program Time	-	1.5	-	μS	Excludes system-level overhead
Chip Programming Time (Each chip)	-	25.2	50.4	sec	Excludes system-level overhead
Erase/Program Endurance	100,000	-	-	cycles	Minimum 100,000 cycles guaranteed

Notes: 1. 25 °C, Vcc = 3.0V 100,000 cycles, typical pattern.

System-level overhead is defined as the time required to execute the four bus cycle command necessary to program each word. In the preprogramming step of the Internal Erase Routine, all words are programmed to 00H before erasure.



SWITCHING WAVEFORMS Conventional Read Operations

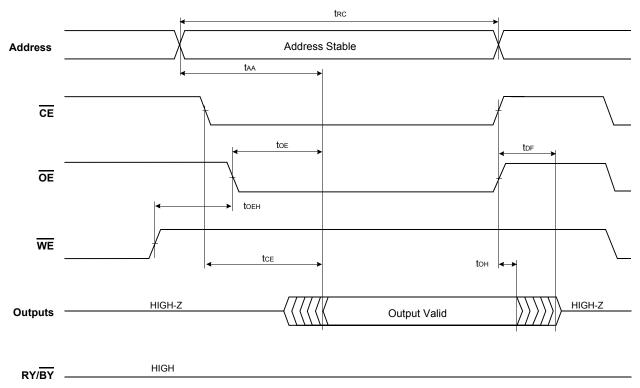


Figure 11. Conventional Read Operation Timings

Parameter	Symbol	4	В	4	С	4	D	Unit
Farameter	Syllibol	Min	Max	Min	Max	Min	Max	Ullit
Read Cycle Time	trc	60	-	65	-	70	-	ns
Address Access Time	taa	-	60	-	65	-	70	ns
Chip Enable Access Time	tce	-	60	-	65	-	70	ns
Output Enable Time	toE	-	25	-	30	-	30	ns
CE & OE Disable Time (1)	tDF	-	16	-	16	-	16	ns
Output Hold Time from Address, $\overline{\text{CE}}$ or $\overline{\text{OE}}$	tон	5	-	5	-	5	-	ns
OE Hold Time	tоен	0	10	0	10	0	10	ns

Note: 1. Not 100% tested.

SWITCHING WAVEFORMS Page Read Operations

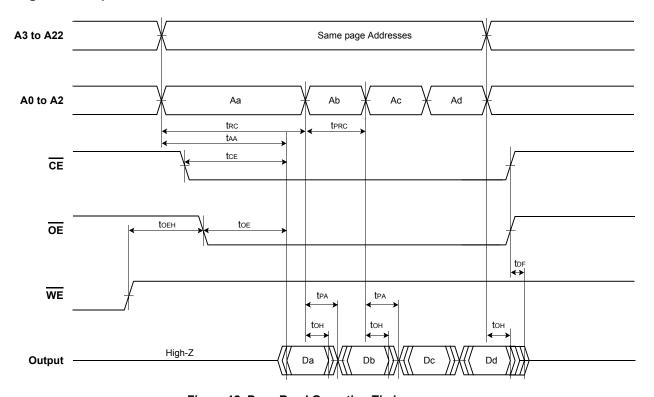


Figure 12. Page Read Operation Timings

Parameter	Symbol	4	В	4	С	4	D	Unit
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Offic
Read Cycle Time	trc	60	-	65	-	70	-	ns
Page Read Cycle Time	tprc	25	-	25	-	30	-	ns
Address Access Time	taa	-	60	-	65	-	70	ns
Page Address Access Time	tPA	-	25	-	25	-	30	ns
Chip Enable Access Time	tce	-	60	-	65	-	70	ns
Output Enable Time	toe	-	25	-	30	-	30	ns
CE & OE Disable Time (1)	tDF	-	16	-	16	-	16	ns
Output Hold Time from Address, CE or OE	tон	5	-	5	-	5	-	ns
OE Hold Time	toeh	0	-	0	-	0	-	ns

Note: 1. Not 100% tested.

SWITCHING WAVEFORMS Hardware Reset/Read Operations

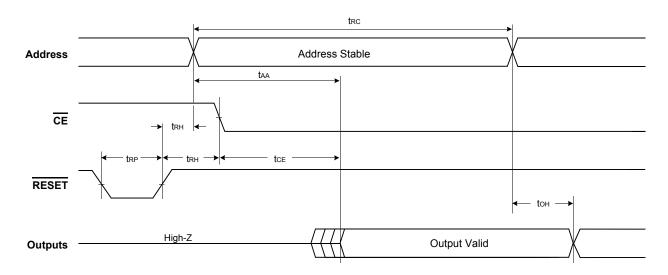
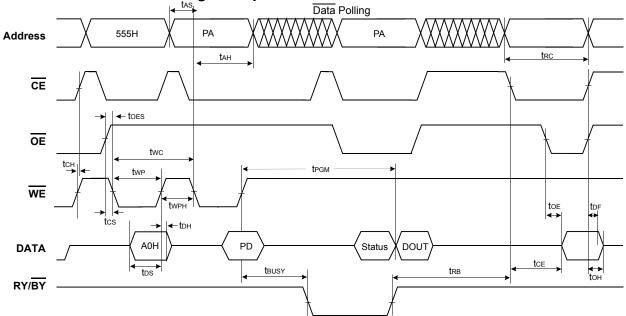


Figure 13. Hardware Reset/Read Operation Timings

Parameter	Symbol	4	4B		4C		D	Unit
Farameter	Symbol	Min	Max	Min	Max	Min	Max	Unit
Read Cycle Time	trc	60	-	65	-	70	-	ns
Address Access Time	taa	-	60	-	65	-	70	ns
Chip Enable Access Time	tce	-	60	-	65	-	70	ns
Output Hold Time from Address, $\overline{\text{CE}}$ or $\overline{\text{OE}}$	tон	5	-	5	-	5	-	ns
RESET Pulse Width	trp	500	-	500	-	500	-	ns
RESET High Time Before Read	tкн	50	-	50	-	50	-	ns

Alternate WE Controlled Program Operations



Notes: 1. DQ7 is the output of the complement of the data written to the device.
2. DOUT is the output of the data written to the device.
3. PA: Program Address, PD: Program Data
4. The illustration shows the last two cycles of the program command sequence.

Figure 14. Alternate WE Controlled Program Operation Timings

Dovemeter	Cumbal	4	В	4	IC	4	ID	Unit
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit
Write Cycle Time	twc	60	-	65	-	70	-	ns
Address Setup Time	tas	0	-	0	-	0	-	ns
Address Hold Time	tah	35	-	35	-	35	-	ns
Data Setup Time	tos	30	-	30	-	30	-	ns
Data Hold Time	tDH	0	-	0	-	0	-	ns
CE Setup Time	tcs	0	-	0	-	0	-	ns
CE Hold Time	tсн	0	-	0	-	0	-	ns
OE Setup Time	toes	0	-	0	-	0	-	ns
Write Pulse Width	twp	35	-	35	-	35	-	ns
Write Pulse Width High	twph	25	-	25	-	25	-	ns
Programming Operation	tрдм	6(1	ур)	6(t	yp.)	6(t	yp.)	us
Accelerated Programming Operation	taccpgm	6(1	yp)	6(t	yp.)	6(t	yp.)	μS
Read Cycle Time	trc	60	-	65	-	70	-	ns
Chip Enable Access Time	tce	-	60	-	65	-	70	ns
Output Enable Time	toe	-	25	-	30	-	30	ns
CE & OE Disable Time	tDF	-	16	-	16	-	16	ns
Output Hold Time from Address, CE or OE	tон	5	-	5	-	5	-	ns
Program/Erase Valid to RY/BY Delay	tBUSY	35	90	35	90	35	90	ns
Recovery Time from RY/BY	trв	0	-	0	-	0	-	ns



Alternate CE Controlled Program Operations

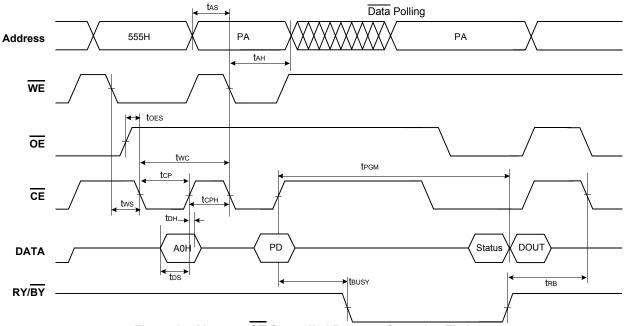


Figure 15. Alternate CE Controlled Program Operation Timings

- Notes: 1. $\overline{DQ7}$ is the output of the complement of the data written to the device.
- 2. DOUT is the output of the data written to the device.
- 3. PA: Program Address, PD: Program Data
- 4. The illustration shows the last two cycles of the program command sequence.

Parameter	Symbol	4	В	4	С	4	D	Unit
Parameter	Syllibol	Min	Max	Min	Max	Min	4D Max	Unit
Write Cycle Time	twc	60	-	65	-	70	-	ns
Address Setup Time	tas	0	-	0	-	0	-	ns
Address Hold Time	tан	35	-	35	-	35	-	ns
Data Setup Time	tos	30	-	30	-	30	-	ns
Data Hold Time	tDH	0	-	0	-	0	-	ns
OE Setup Time	toes	0	-	0	-	0	-	ns
WE Setup Time	tws	0	-	0	-	0	-	ns
WE Hold Time	twн	0	-	0	-	0	-	ns
CE Pulse Width	tcp	40	-	40	-	40	-	ns
CE Pulse Width High	tсрн	25	-	25	-	25	-	ns
Programming Operation	tрдм	6(t	yp)	6(ty	/p.)	6(t	yp.)	μS
Accelerated Programming Operation	taccpgm	6(t	yp)	6(ty	/p.)	6(t <u>y</u>	yp.)	μ\$
Program/Erase Valid to RY/BY Delay	tBUSY	35	90	35	90	35	90	ns
Recovery Time from RY/BY	tпв	0	-	0	-	0	-	ns

SWITCHING WAVEFORMS Chip/Block Erase Operations

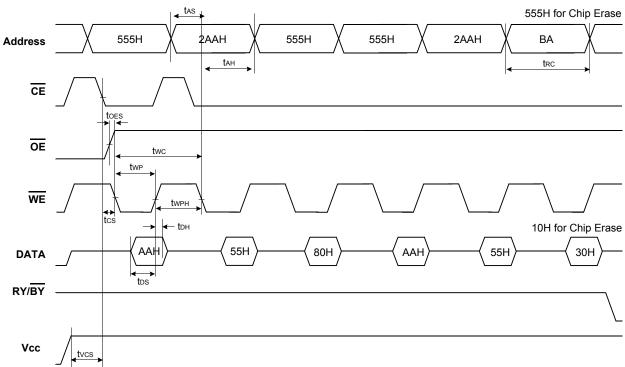


Figure 16. Chip/Block Erase Operation Timings

Note: BA: Block Address

Parameter	Symbol	4	В	4	С	4	D	Unit
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit
Write Cycle Time	twc	60	-	65	-	70	-	ns
Address Setup Time	tas	0	-	0	-	0	-	ns
Address Hold Time	tан	35	-	35	-	35	-	ns
Data Setup Time	tos	30	-	30	-	30	-	ns
Data Hold Time	tон	0	-	0	-	0	-	ns
OE Setup Time	toes	0	-	0	-	0	-	ns
CE Setup Time	tcs	0	-	0	-	0	-	ns
Write Pulse Width	twp	35	-	35	-	35	-	ns
Write Pulse Width High	twph	25	-	25	-	25	-	ns
Read Cycle Time	trc	60	-	65	-	70	-	ns
Vcc Set Up Time	tvcs	50	-	50	-	50	-	μS

SWITCHING WAVEFORMS Read While Write Operations

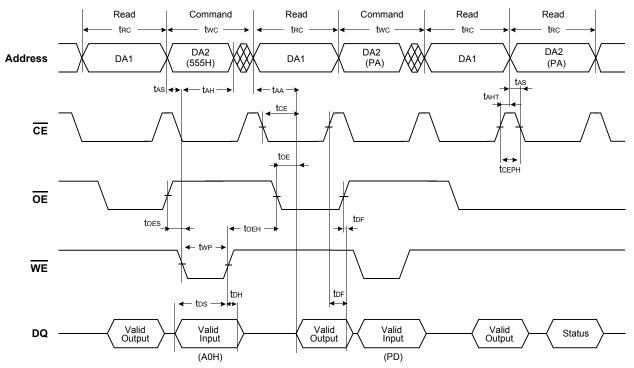


Figure 17. Read While Write Operation Timings

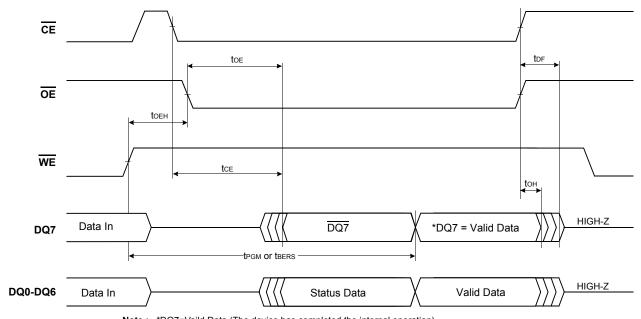
Note: This is an example in the program-case of the Read While Write function. DA1: Address of Bank1, DA2: Address of Bank2

PA = Program Address at one bank , RA = Read Address at the other bank, PD = Program Data In , RD = Read Data Out

Downworton	Comple ed	4	В	4	C	4	ID.	Unit
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit
Write Cycle Time	twc	60	-	65	-	70	-	ns
Write Pulse Width	twp	35	-	35	-	35	-	ns
Write Pulse Width High	twph	25	-	25	-	25	-	ns
Address Setup Time	tas	0	-	0	-	0	-	ns
Address Hold Time	tah	35	-	35	-	35	-	ns
Data Setup Time	tos	30	-	30	-	30	-	ns
Data Hold Time	tон	0	-	0	-	0	-	ns
Read Cycle Time	trc	60	-	65	-	70	-	ns
Chip Enable Access Time	tcE	-	60	-	65	-	70	ns
Address Access Time	taa	-	60	-	65	-	70	ns
Output Enable Access Time	toE	-	25	-	30	-	30	ns
OE Setup Time	toes			0	-	0	-	ns
OE Hold Time	tоен	10	-	10	-	10	-	ns
CE & OE Disable Time	tDF	-	16	-	16	-	16	ns
Address Hold Time	taht	35	-	35	-	35	-	ns
CE High during toggle bit polling	tсерн	20	-	20	-	20	-	ns



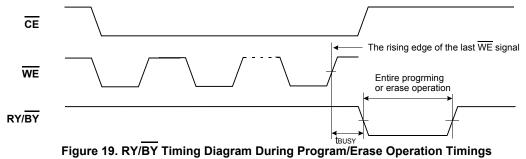
Data Polling During Internal Routine Operation



Note: *DQ7=Vaild Data (The device has completed the internal operation).

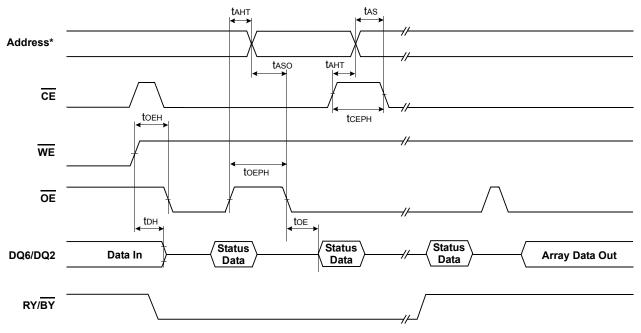
Figure 18. Data Polling During Internal Routine Operation Timings

RY/BY Timing Diagram During Program/Erase Operation



Parameter	Symbol	4	В	4	С	4	D	Unit
raiametei	Symbol	Min	Max	Min	Max	Min	Max	Oille
Program/Erase Valid to RY/BY Delay	tBUSY	35	90	35	90	35	90	ns
Chip Enable Access Time	tce	-	60	-	65	-	70	ns
Output Enable Time	toE	-	25	-	30	-	30	ns
CE & OE Disable Time	tDF	-	16	-	16	-	16	ns
Output Hold Time from Address, CE or OE	tон	5	-	5	-	5	-	ns
OE Hold Time	toeh	10	-	10	-	10	-	ns

SWITCHING WAVEFORMS Toggle Bit During Internal Routine Operation



Note: Address for the write operation must include a bank address (A19~A22) where the data is written.

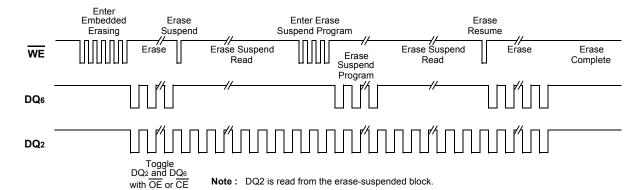
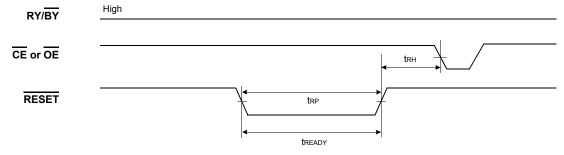


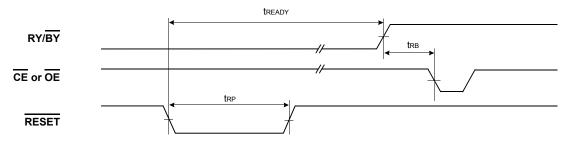
Figure 20. Toggle Bit During Internal Routine Operation Timings

Parameter	Cumbal	4	В	4	C	4	D	Unit
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit
Output Enable Access Time	toE	-	25	-	30	-	30	ns
OE Hold Time	toeh	10	-	10	-	10	-	ns
Address Hold Time	taht	35	-	35	-	35	-	ns
Address Setup	taso	55	-	55	-	55	-	ns
Address Setup Time	tas	0	-	0	-	0	-	ns
Data Hold Time	tон	0	-	0	-	0	-	ns
CE High during toggle bit polling	tceph	20	-	20	-	20	-	ns
OE High during toggle bit polling	toeph	10	-	10	-	10	-	ns

RESET Timing Diagram



Reset Timings NOT during Internal Routine



Reset Timings during Internal Routine

Power-up and RESET Timing Diagram

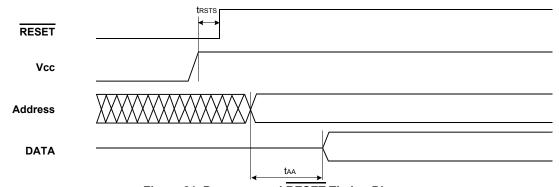
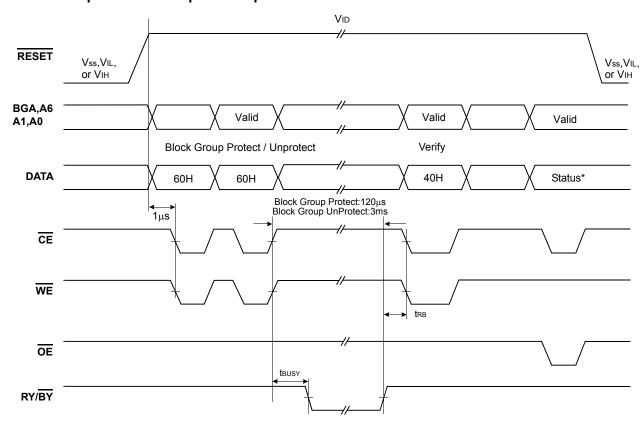


Figure 21. Power-up and RESET Timing Diagram

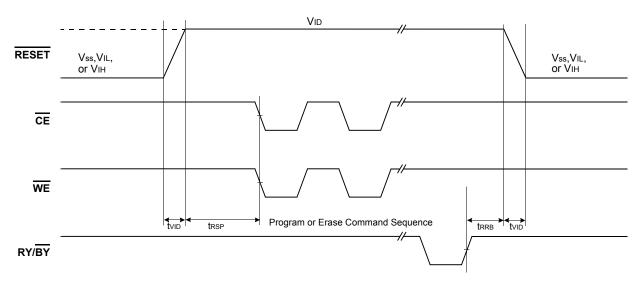
Dovometer	Cumbal	4	В	4	С	4	D	Unit
Parameter	Symbol	Min	Max	Min	Max	Min	Max	Unit
RESET Pulse Width	trp	500	-	500	-	500	-	ns
RESET Low to Valid Data (During Internal Routine)	tREADY	-	20	-	20	-	20	μS
RESET Low to Valid Data (Not during Internal Routine)	tREADY	-	500	-	500	-	500	ns
RESET High Time Before Read	tкн	50	-	50	-	50	-	ns
RY/BY Recovery Time	tпв	0	-	0	-	0	-	ns
RESET High to Address Valid	trstw	200	-	200	-	200	-	ns
RESET Low Set-up Time	trsts	500	-	500	-	500	-	ns

SWITCHING WAVEFORMSBlock Group Protect & Unprotect Operations



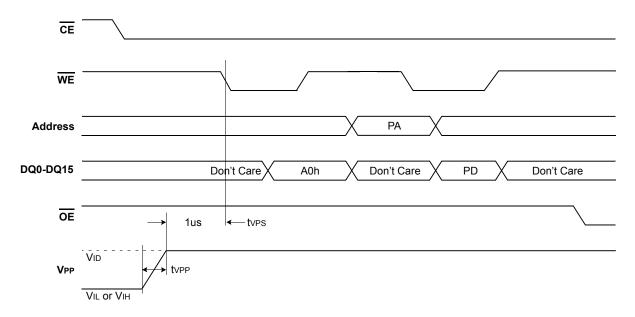
Notes: Block Group Protect (A6=VIL, A1=VIH, A0=VIL), Status=01H Block Group Unprotect (A6=VIH, A1=VIH, A0=VIL), Status=00H BGA = Block Group Address (A12 ~ A22)

Temporary Block Group Unprotect

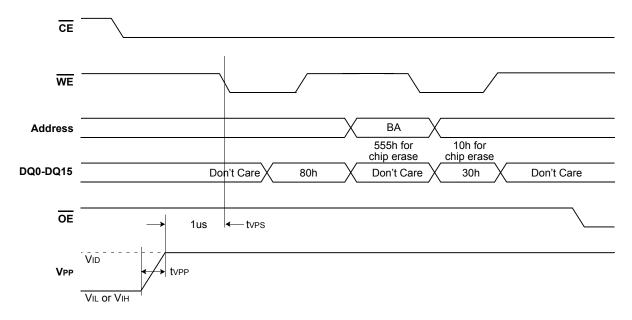




Unlock Bypass Program Operations(Accelerated Program)



Unlock Bypass Block Erase Operations



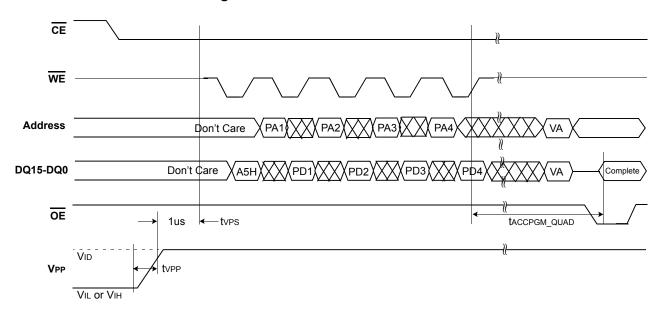
Notes:

- 1. VPP can be left high for subsequent programming pulses.
- 2. Use setup and hold times from conventional program operations.
- 3. Unlock Bypass Program/Erase commands can be used when the $\mbox{V}_{\mbox{\scriptsize ID}}$ is applied to $\mbox{\scriptsize Vpp}.$

Figure 22. Unlock Bypass Operation Timings



Quad word Accelerated Program



Notes:

- 1. VPP can be left high for subsequent programming pulses.
- 2. Use setup and hold times from conventional program operations.
- 3. Quad word Acelerate program commands can be used when the \mbox{VID} is applied to $\mbox{Vpp}.$

Figure 23. Quad word Accelerated Program Operation Timings



Table 13. Block Architecture (K8Q2815UQB) (2nd chip)

Bank	A22	Block	Block Size	(x16) Address Range
		BA283	4 Kwords	6FF000h-6FFFFh
		BA282	4 Kwords	6FE000h-6FEFFFh
		BA281	4 Kwords	6FD000h-6FDFFFh
		BA280	4 Kwords	6FC000h-6FCFFFh
		BA279	4 Kwords	6FB000h-6FBFFFh
		BA278	4 Kwords	6FA000h-6FAFFFh
		BA277	4 Kwords	6F9000h-6F9FFh
		BA276	4 Kwords	6F8000h-6F8FFFh
		BA275	32 Kwords	6F0000h-6F7FFh
		BA274	32 Kwords	6E8000h-6EFFFFh
		BA273	32 Kwords	6E0000h-6E7FFh
Bank 7		BA272	32 Kwords	6D8000h-6DFFFFh
		BA271	32 Kwords	6D0000h-6D7FFFh
		BA270	32 Kwords	6C8000h-6CFFFFh
		BA269	32 Kwords	6C0000h-6C7FFh
		BA268	32 Kwords	6B8000h-6BFFFFh
		BA267	32 Kwords	6B0000h-6B7FFFh
		BA266	32 Kwords	6A8000h-6AFFFFh
		BA265	32 Kwords	6A0000h-6A7FFFh
		BA264	32 Kwords	698000h-69FFFFh
		BA263	32 Kwords	690000h-697FFFh
		BA262	32 Kwords	688000h-68FFFFh
	A22 ='1'	BA261	32 Kwords	680000h-687FFFh
		BA260	32 Kwords	678000h-67FFFh
		BA259	32 Kwords	670000h-677FFFh
		BA258	32 Kwords	668000h-66FFFFh
		BA257	32 Kwords	660000h-667FFFh
		BA256	32 Kwords	658000h-65FFFFh
		BA255	32 Kwords	650000h-657FFFh
		BA254	32 Kwords	648000h-64FFFh
		BA253	32 Kwords	640000h-647FFFh
		BA252	32 Kwords	638000h-63FFFFh
		BA251	32 Kwords	630000h-637FFFh
		BA250	32 Kwords	628000h-62FFFFh
Bank 6		BA249	32 Kwords	620000h-627FFFh
		BA248	32 Kwords	618000h-61FFFFh
		BA247	32 Kwords	610000h-617FFFh
		BA246	32 Kwords	608000h-60FFFh
		BA245	32 Kwords	600000h-607FFh
		BA244	32 Kwords	6F8000h-6FFFFFh
		BA243	32 Kwords	6F0000h-6F7FFFh
		BA242	32 Kwords	6E8000h-6EFFFFh
		BA241	32 Kwords	6E0000h-6E7FFFh
		BA240	32 Kwords	6D8000h-6DFFFFh
		BA239	32 Kwords	6D0000h-6D7FFFh

Table 13. Block Architecture (K8Q2815UQB) (2nd chip)

Bank	A22	Block	Block Size	(x16) Address Range
		BA238	32 Kwords	6C8000h-6CFFFFh
		BA237	32 Kwords	6C0000h-6C7FFFh
		BA236	32 Kwords	6B8000h-6BFFFFh
		BA235	32 Kwords	6B0000h-6B7FFFh
		BA234	32 Kwords	6A8000h-6AFFFh
		BA233	32 Kwords	6A0000h-6A7FFFh
		BA232	32 Kwords	698000h-69FFFFh
		BA231	32 Kwords	690000h-697FFFh
		BA230	32 Kwords	688000h-68FFFFh
		BA229	32 Kwords	680000h-687FFFh
		BA228	32 Kwords	678000h-67FFFh
		BA227	32 Kwords	670000h-677FFFh
		BA226	32 Kwords	668000h-66FFFh
Bank 6		BA225	32 Kwords	660000h-667FFh
		BA224	32 Kwords	658000h-65FFFh
		BA223	32 Kwords	650000h-657FFh
		BA222	32 Kwords	648000h-64FFFh
		BA221	32 Kwords	640000h-647FFh
		BA220	32 Kwords	638000h-63FFFFh
		BA219	32 Kwords	630000h-637FFFh
		BA218	32 Kwords	628000h-62FFFFh
		BA217		620000h-627FFFh
	A 22 -'1'	BA217	32 Kwords 32 Kwords	618000h-61FFFFh
	A22 ='1'			
		BA215	32 Kwords	610000h-617FFh
		BA214	32 Kwarda	608000h-60FFFFh
		BA213	32 Kwords	600000h-607FFFh
		BA212	32 Kwords	5F8000h-5FFFFFh
		BA211	32 Kwords	5F0000h-5F7FFh
		BA210	32 Kwords	5E8000h-5EFFFFh
	-	BA209	32 Kwords	5E0000h-5E7FFFh
		BA208	32 Kwords	5D8000h-5DFFFFh
		BA207	32 Kwords	5D0000h-5D7FFFh
	-	BA206	32 Kwords	5C8000h-5CFFFFh
		BA205	32 Kwords	5C0000h-5C7FFFh
		BA204	32 Kwords	5B8000h-5BFFFFh
Bank 5		BA203	32 Kwords	5B0000h-5B7FFFh
		BA202	32 Kwords	5A8000h-5AFFFFh
		BA201	32 Kwords	5A0000h-5A7FFFh
		BA200	32 Kwords	598000h-59FFFh
		BA199	32 Kwords	590000h-597FFFh
		BA198	32 Kwords	588000h-58FFFFh
		BA197	32 Kwords	580000h-587FFFh
		BA196	32 Kwords	578000h-57FFFh
		BA195	32 Kwords	570000h-577FFFh
	Ţ	BA194	32 Kwords	568000h-56FFFFh



Table 13. Block Architecture (K8Q2815UQB) (2nd chip)

Bank	A22	Block	Block Size	(x16) Address Range
		BA193	32 Kwords	560000h-567FFh
		BA192	32 Kwords	558000h-55FFFFh
		BA191	32 Kwords	550000h-557FFh
		BA190	32 Kwords	548000h-54FFFFh
		BA189	32 Kwords	540000h-547FFh
		BA188	32 Kwords	538000h-53FFFFh
		BA187	32 Kwords	530000h-537FFFh
		BA186	32 Kwords	528000h-52FFFFh
		BA185	32 Kwords	520000h-527FFh
		BA184	32 Kwords	518000h-51FFFFh
		BA183	32 Kwords	510000h-517FFh
		BA182	32 Kwords	508000h-50FFFh
		BA181	32 Kwords	500000h-507FFh
		BA180	32 Kwords	4F8000h-4FFFFh
Bank 5		BA179	32 Kwords	4F0000h-4F7FFFh
		BA178	32 Kwords	4E8000h-4EFFFFh
		BA177	32 Kwords	4E0000h-4E7FFFh
		BA176	32 Kwords	4D8000h-4DFFFFh
		BA175	32 Kwords	4D0000h-4D7FFFh
		BA174	32 Kwords	4C8000h-4CFFFFh
		BA173	32 Kwords	4C0000h-4C7FFFh
		BA172	32 Kwords	4B8000h-4BFFFFh
	A22 ='1'	BA171	32 Kwords	4B0000h-4B7FFFh
		BA170	32 Kwords	4A8000h-4AFFFFh
		BA169	32 Kwords	4A0000h-4A7FFFh
		BA168	32 Kwords	498000h-49FFFFh
		BA167	32 Kwords	490000h-497FFFh
		BA166	32 Kwords	488000h-48FFFFh
		BA165	32 Kwords	480000h-487FFFh
		BA164	32 Kwords	478000h-47FFFh
		BA163	32 Kwords	470000h-477FFFh
		BA162	32 Kwords	468000h-46FFFFh
		BA161	32 Kwords	460000h-467FFFh
		BA160	32 Kwords	458000h-45FFFFh
		BA159	32 Kwords	450000h-457FFFh
		BA158	32 Kwords	448000h-44FFFFh
5 , .		BA157	32 Kwords	440000h-447FFFh
Bank 4		BA156	32 Kwords	438000h-43FFFFh
		BA155	32 Kwords	430000h-437FFFh
		BA154	32 Kwords	428000h-42FFFFh
		BA153	32 Kwords	420000h-427FFh
		BA152	32 Kwords	418000h-41FFFFh
		BA151	32 Kwords	410000h-417FFFh
		BA150	32 Kwords	408000h-40FFFFh
		BA149	4 Kwords	407000h-407FFFh



Table 13. Block Architecture (K8Q2815UQB) (2nd chip)

Bank	A22	Block	Block Size	(x16) Address Range
Bank 4	A22 ='1'	BA148	4 Kwords	406000h-406FFFh
		BA147	4 Kwords	405000h-405FFFh
		BA146	4 Kwords	404000h-404FFFh
		BA145	4 Kwords	403000h-403FFFh
		BA144	4 Kwords	402000h-402FFFh
		BA143	4 Kwords	401000h-401FFFh
		BA142	4 Kwords	400000h-400FFFh

Table 13. Block Architecture (K8Q2815UQB) (1st chip)

Bank	A22	Block	Block Size	(x16) Address Range
		BA141	4 Kwords	3FF000h-3FFFFFh
		BA140	4 Kwords	3FE000h-3FEFFFh
		BA139	4 Kwords	3FD000h-3FDFFFh
		BA138	4 Kwords	3FC000h-3FCFFFh
		BA137	4 Kwords	3FB000h-3FBFFFh
		BA136	4 Kwords	3FA000h-3FAFFFh
		BA135	4 Kwords	3F9000h-3F9FFFh
		BA134	4 Kwords	3F8000h-3F8FFFh
		BA133	32 Kwords	3F0000h-3F7FFFh
		BA132	32 Kwords	3E8000h-3EFFFFh
		BA131	32 Kwords	3E0000h-3E7FFFh
Bank 3		BA130	32 Kwords	3D8000h-3DFFFFh
		BA129	32 Kwords	3D0000h-3D7FFFh
		BA128	32 Kwords	3C8000h-3CFFFFh
		BA127	32 Kwords	3C0000h-3C7FFFh
		BA126	32 Kwords	3B8000h-3BFFFFh
		BA125	32 Kwords	3B0000h-3B7FFFh
		BA124	32 Kwords	3A8000h-3AFFFFh
		BA123	32 Kwords	3A0000h-3A7FFFh
		BA122	32 Kwords	398000h-39FFFFh
		BA121	32 Kwords	390000h-397FFFh
		BA120	32 Kwords	388000h-38FFFFh
	A22 = '0'	BA119	32 Kwords	380000h-387FFFh
		BA118	32 Kwords	378000h-37FFFFh
		BA117	32 Kwords	370000h-377FFFh
		BA116	32 Kwords	368000h-36FFFFh
		BA115	32 Kwords	360000h-367FFFh
		BA114	32 Kwords	358000h-35FFFFh
		BA113	32 Kwords	350000h-357FFFh
		BA112	32 Kwords	348000h-34FFFFh
		BA111	32 Kwords	340000h-347FFFh
		BA110	32 Kwords	338000h-33FFFFh
		BA109	32 Kwords	330000h-337FFFh
		BA108	32 Kwords	328000h-32FFFFh
Bank 2		BA107	32 Kwords	320000h-327FFFh
		BA106	32 Kwords	318000h-31FFFFh
		BA105	32 Kwords	310000h-317FFFh
		BA104	32 Kwords	308000h-30FFFFh
		BA103	32 Kwords	300000h-307FFFh
		BA102	32 Kwords	2F8000h-2FFFFFh
	-	BA101	32 Kwords	2F0000h-2F7FFFh
	-	BA100	32 Kwords	2E8000h-2EFFFFh
		BA99	32 Kwords	2E0000h-2E7FFFh
		BA98	32 Kwords	2D8000h-2DFFFFh
		2, 100	OE INVOIGS	EDOUGHT EDITITI

Table 13. Block Architecture (K8Q2815UQB) (1st chip)

Bank	A22	Block	Block Size	(x16) Address Range
		BA96	32 Kwords	2C8000h-2CFFFFh
		BA95	32 Kwords	2C0000h-2C7FFFh
		BA94	32 Kwords	2B8000h-2BFFFFh
		BA93	32 Kwords	2B0000h-2B7FFFh
		BA92	32 Kwords	2A8000h-2AFFFFh
		BA91	32 Kwords	2A0000h-2A7FFFh
		BA90	32 Kwords	298000h-29FFFFh
		BA89	32 Kwords	290000h-297FFFh
		BA88	32 Kwords	288000h-28FFFFh
		BA87	32 Kwords	280000h-287FFFh
		BA86	32 Kwords	278000h-27FFFh
		BA85	32 Kwords	270000h-277FFFh
		BA84	32 Kwords	268000h-26FFFFh
Bank 2		BA83	32 Kwords	260000h-267FFFh
		BA82	32 Kwords	258000h-25FFFFh
		BA81	32 Kwords	250000h-257FFFh
		BA80	32 Kwords	248000h-24FFFFh
		BA79	32 Kwords	240000h-247FFFh
		BA78	32 Kwords	238000h-23FFFFh
		BA77	32 Kwords	230000h-237FFFh
		BA76	32 Kwords	228000h-22FFFFh
		BA75	32 Kwords	220000h-227FFh
	A22 = '0'	BA74	32 Kwords	218000h-21FFFFh
		BA73	32 Kwords	210000h-217FFFh
		BA72	32 Kwords	208000h-20FFFFh
		BA71	32 Kwords	200000h-207FFh
		BA70	32 Kwords	1F8000h-1FFFFFh
		BA69	32 Kwords	1F0000h-1F7FFFh
		BA68	32 Kwords	1E8000h-1EFFFFh
		BA67	32 Kwords	1E0000h-1E7FFFh
		BA66	32 Kwords	1D8000h-1DFFFFh
		BA65	32 Kwords	1D0000h-1D7FFFh
		BA64	32 Kwords	1C8000h-1CFFFFh
		BA63	32 Kwords	1C0000h-1C7FFFh
		BA62	32 Kwords	1B8000h-1BFFFFh
Bank 1		BA61	32 Kwords	1B0000h-1B7FFFh
		BA60	32 Kwords	1A8000h-1AFFFFh
		BA59	32 Kwords	1A0000h-1A7FFFh
		BA58	32 Kwords	198000h-19FFFFh
		BA57	32 Kwords	190000h-197FFh
	-	BA56	32 Kwords	188000h-18FFFFh
	-	BA55	32 Kwords	180000h-187FFFh
		BA54	32 Kwords	178000h-17FFFFh
		BA53	32 Kwords	170000h-177FFFh
		BA52	32 Kwords	168000h-16FFFh

Table 13. Block Architecture (K8Q2815UQB) (1st chip)

Bank	A22	Block	Block Size	(x16) Address Range
		BA51	32 Kwords	160000h-167FFFh
		BA50	32 Kwords	158000h-15FFFFh
		BA49	32 Kwords	150000h-157FFFh
		BA48	32 Kwords	148000h-14FFFFh
		BA47	32 Kwords	140000h-147FFFh
		BA46	32 Kwords	138000h-13FFFFh
		BA45	32 Kwords	130000h-137FFFh
		BA44	32 Kwords	128000h-12FFFFh
		BA43	32 Kwords	120000h-127FFFh
		BA42	32 Kwords	118000h-11FFFFh
		BA41	32 Kwords	110000h-117FFFh
		BA40	32 Kwords	108000h-10FFFFh
		BA39	32 Kwords	100000h-107FFFh
		BA38	32 Kwords	0F8000h-0FFFFh
Bank 1		BA37	32 Kwords	0F0000h-0F7FFh
	F	BA36	32 Kwords	0E8000h-0EFFFFh
	F	BA35	32 Kwords	0E0000h-0E7FFh
		BA34	32 Kwords	0D8000h-0DFFFFh
		BA33	32 Kwords	0D0000h-0D7FFFh
		BA32	32 Kwords	0C8000h-0CFFFFh
		BA31	32 Kwords	0C0000h-0C7FFFh
		BA30	32 Kwords	0B8000h-0BFFFFh
	A22 ='0'	BA29	32 Kwords	0B0000h-0B7FFFh
		BA28	32 Kwords	0A8000h-0AFFFFh
		BA27	32 Kwords	0A0000h-0A7FFFh
		BA26	32 Kwords	098000h-09FFFFh
		BA25	32 Kwords	090000h-097FFFh
		BA24	32 Kwords	088000h-08FFFFh
		BA23	32 Kwords	080000h-087FFFh
		BA22	32 Kwords	078000h-07FFFFh
		BA21	32 Kwords	070000h-077FFFh
		BA20	32 Kwords	068000h-06FFFFh
		BA19	32 Kwords	060000h-067FFFh
		BA18	32 Kwords	058000h-05FFFFh
		BA17	32 Kwords	050000h-057FFFh
		BA16	32 Kwords	048000h-04FFFFh
Bank 0		BA15	32 Kwords	040000h-047FFFh
Dailk U		BA14	32 Kwords	038000h-03FFFFh
		BA13	32 Kwords	030000h-037FFFh
		BA12	32 Kwords	028000h-02FFFFh
		BA11	32 Kwords	020000h-027FFFh
		BA10	32 Kwords	018000h-01FFFFh
		BA9	32 Kwords	010000h-017FFFh
		BA8	32 Kwords	008000h-00FFFFh
		BA7	4 Kwords	007000h-007FFFh

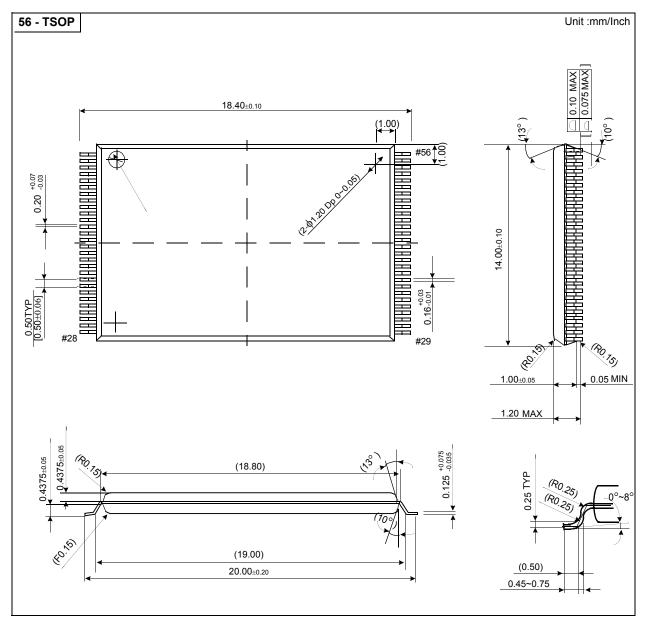


Table 13. Block Architecture (K8Q2815UQB) (1st chip)

Bank	A22	Block	Block Size	(x16) Address Range
	A22 ='0'	BA6	4 Kwords	006000h-006FFFh
		BA5	4 Kwords	005000h-005FFFh
		BA4	4 Kwords	004000h-004FFFh
Bank 0		BA3	4 Kwords	003000h-003FFFh
		BA2	4 Kwords	002000h-002FFFh
		BA1	4 Kwords	001000h-001FFFh
		BA0	4 Kwords	000000h-000FFFh

PACKAGE DIMENSIONS

56-PIN LEAD PLASTIC THIN SMALL OUT-LINE PACKAGE TYPE



NOTE

() is reference.

[] is Assambly Out Quality.

